



# THE DATASHEET OF THS8083APZP

# **THS8083A**

***Triple 8-Bit, 80 MSPS, 3.3-V Video and Graphics  
Digitizer With Digital PLL***

## *Data Manual*

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# 1 Introduction

The THS8083A is a complete solution for digitizing video and graphic signals in RGB or YUV/YCbCr color spaces. The device supports pixel rates up to 80 MHz. Therefore, it can be used for PC graphics digitizing up to the VESA standard of XGA (1024 X 768) resolution at 75 Hz screen refresh rate, and in video environments for the digitizing of digital TV formats, including HDTV.

The THS8083A is powered from a single 3.3-V supply and integrates a triple high-performance A/D converter with clamping functions and variable gain, independently programmable for each channel. The clamp timing window is provided by an external pulse or can be generated internally. The programmable gain amplifiers consist of coarse and fine gain control blocks. The THS8083A includes slicing circuitry on the Y or G input to support sync-on-green or sync-on-luminance extraction.

The THS8083A also contains a completely digital PLL block consisting of phase-frequency detector (PFD), discrete time oscillator (DTO), and programmable divider to generate the (sampling) clock from the incoming horizontal sync (HS) signal, depending on the incoming video resolution. Any pixel rate can be generated in the 13–80 MHz range. Moreover, the output phase of the synthesized clock can be controlled with subpixel accuracy (31 uniform settings).

Programmable time constants allow changing the PLL loop bandwidth by the integrated PLL loop filter. Alternatively, the user may bypass the PLL when an external pixel clock is available. Even then the DTO synthesized clock is still available externally and can therefore be used in other parts of the (graphics) system. Extensive PLL and input monitoring functions are integrated for typical functionality required in LCD/DMD monitor/projection systems (input format detection, autocalibration).

All programming of the part is done via an industry-standard normal/fast I<sup>2</sup>C interface, which supports both reading and writing of register settings. The THS8083A is available in a space-saving TQFP 100-pin PowerPAD™ package.

## 1.1 Features

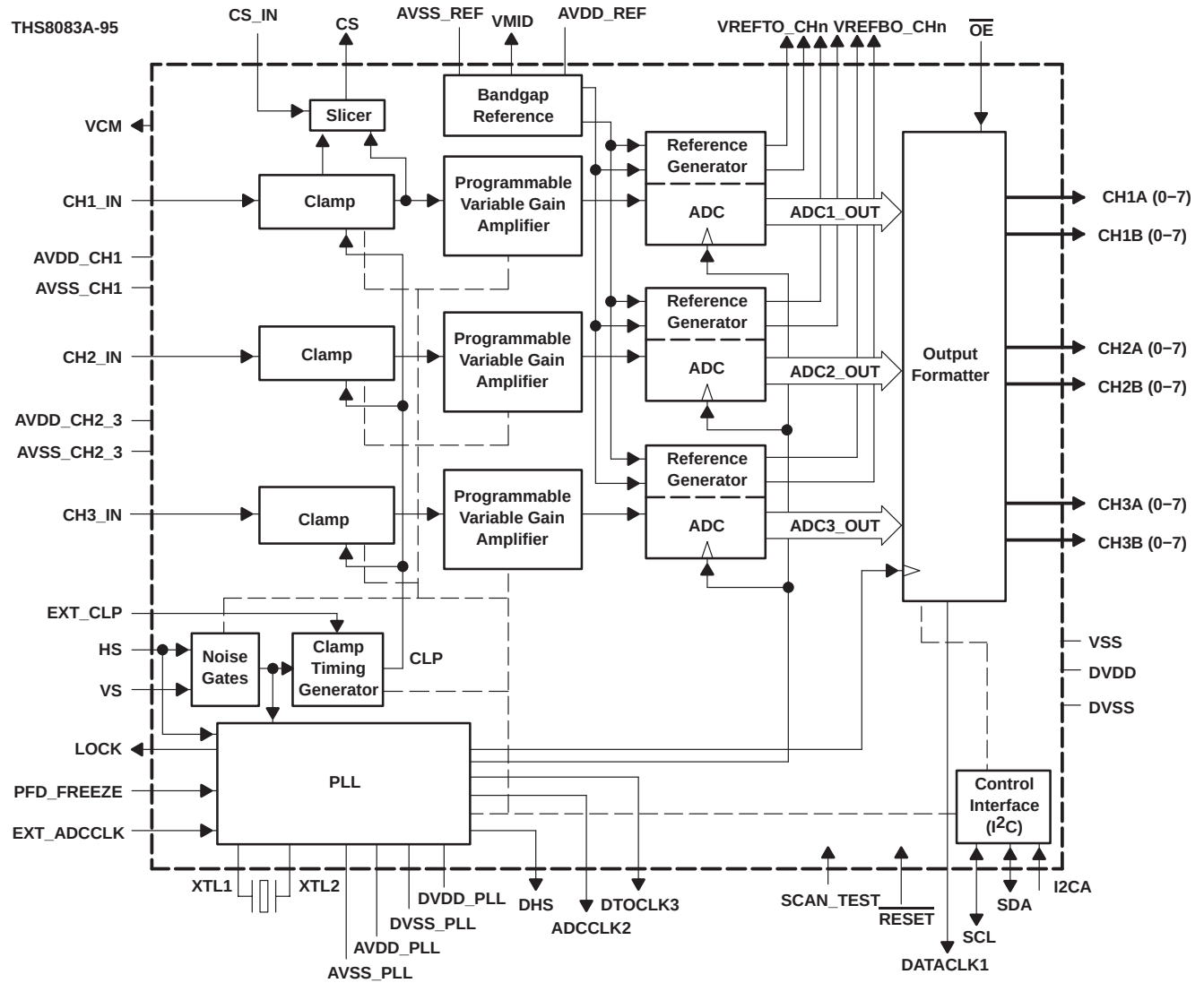
The THS8083A supports the following features:

- Analog Channels – Three digitizing channels, each with independently controllable clamp, PGA, and ADC
  - Clamp: 256-step programmable RGB or YUV clamping during external or internal clamp timing window
  - PGA: 6-bit coarse/5-bit fine programmable gain amplifier
  - ADC: 8 bit 80 MSPS A/D converter
  - Composite sync: Integrated sync-on-green/sync-on-luminance extraction from green/luminance channel or from dedicated input
  - Support for dc and ac-coupled input signals
- PLL
  - Fully integrated digital PLL (including loop filter) for pixel clock generation
  - 13-80 MHz pixel clock generation from reference input
  - Adjustable PLL loop bandwidth for minimum jitter or fast acquisition/wide capture range modes
  - 5-bit programmable subpixel accurate positioning of sampling phase
  - Noise gates on HS and VS inputs to avoid false PLL updating

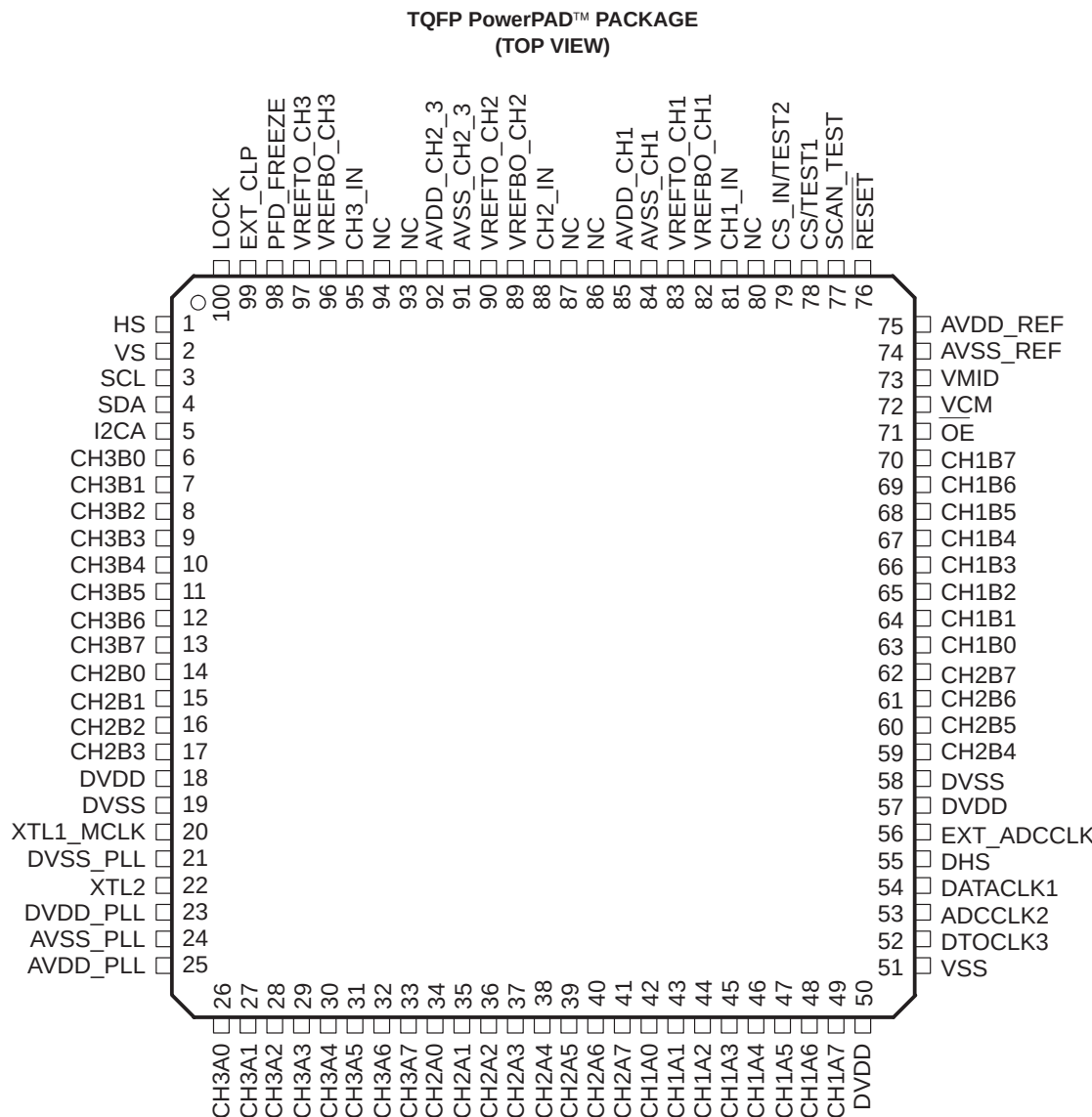
PowerPAD is a trademark of Texas Instruments.

- Output Formatter
  - Single and double pixel width output data bus for reduced board clock frequency and EMI
  - Support for 4:4:4 and 4:2:2 (ITU-R BT.601 style) output modes to reduce board traces
  - Dedicated DATACLK output for easy latching of output data
- System
  - Industry-standard normal/fast I<sup>2</sup>C interface with register readback capability
  - Support for input format detection via integrated monitoring of HS, VS, and pixel clock frequencies
  - Support for multidevice operation (master/slave operation for SXGA resolution)
  - Space-saving TQFP-100 pin package
  - Thermally-enhanced PowerPAD package for better heat dissipation
- Applications
  - LCD desktop monitors and LCD or DMD-based projection systems
  - Videoconferencing
  - PCTV set-top boxes, digital TV sets, and multimedia cards
  - Scan rate/image resolution converters
  - Video/graphics digitizing equipment (RGB or YUV-based)

## 1.2 Functional Block Diagram



1.3 Terminal Assignments



1.4 Ordering Information

| T <sub>A</sub>          | PACKAGED DEVICES |
|-------------------------|------------------|
|                         | TQFP-100         |
| Maximum clock frequency | 80 MSPS          |
| 0°C to 70°C             | THS8083APZP      |

## 1.5 Abbreviations Used in This Document

|                  |                                       |
|------------------|---------------------------------------|
| PGA              | Programmable gain amplifier           |
| PLL              | Phase-locked loop                     |
| I <sup>2</sup> C | Inter-IC interface                    |
| EMI              | Electro-magnetic interference         |
| NTSC             | National Television Systems Committee |
| PAL              | Phase alternating line                |
| DTV              | Digital TV                            |
| VBI              | Vertical blanking interval            |
| CS               | Composite sync                        |

## 1.6 Conventions

Throughout this document, the term YUV refers to a video/graphics signal, consisting of three components, of which one component (Y) has its blanking level corresponding to the bottom level of the video signal range. The other two components (U&V) have their blanking level at the mid-scale of the video signal range, because U&V are color difference signals and thus, can go positive or negative with respect to blanking.

YUV, therefore, should not be restricted to NTSC/PAL component formats, but also includes baseband component video formats used in DTV that should in a strict sense be denoted as analog YCbCr or YPbPr.

The term RGB refers to a video/graphics signal, consisting of three components, of which all components have their blanking level corresponding to the bottom level of the video signal range. Therefore, it relates to both RGB PC formats as well as red-green-blue video component signals, sometimes denoted as GBR instead of RGB in video broadcast environments.

## 1.7 THS8083A Terminal Functions

| TERMINAL<br>NAME      | NO.        | I/O/B <sup>†</sup> | TYPE <sup>‡</sup> | DESCRIPTION                                                       |
|-----------------------|------------|--------------------|-------------------|-------------------------------------------------------------------|
| <b>POWER SUPPLIES</b> |            |                    |                   |                                                                   |
| AVSS_PLL              | 24         | I                  | A                 | Analog ground for PLL (XTL oscillator and analog PLL)             |
| AVDD_PLL              | 25         | I                  | A                 | Analog supply (3.3 V) for analog PLL                              |
| DVSS_PLL              | 21         | I                  | A                 | Digital ground for digital PLL                                    |
| DVDD_PLL              | 23         | I                  | A                 | Digital supply (3.3 V) for digital PLL                            |
| AVSS_CH1              | 84         | I                  | A                 | Analog ground for A/D channel 1                                   |
| AVDD_CH1              | 85         | I                  | A                 | Analog supply (3.3 V) for A/D channel 1                           |
| AVSS_CH2_3            | 91         | I                  | A                 | Analog ground for A/D channel 2 and channel 3                     |
| AVDD_CH2_3            | 92         | I                  | A                 | Analog supply (3.3 V) for A/D channel 2 and channel 3             |
| DVDD                  | 18, 50, 57 | I                  | A                 | Digital supply for all logic, except digital PLL                  |
| DVSS                  | 19, 58     | I                  | A                 | Digital ground for all logic, except digital PLL                  |
| VSS                   | 51         | I                  | A                 | Substrate ground                                                  |
| AVDD_REF              | 75         | I                  | A                 | Analog supply (3.3 V) for voltage and current reference generator |
| AVSS_REF              | 74         | I                  | A                 | Analog ground (3.3 V) for voltage and current reference generator |

<sup>†</sup> I = input to device; O = output from device; B = bidirectional

<sup>‡</sup> A = analog pin; D = digital pin

## 1.7 THS8083A Terminal Functions Order (Continued)

| TERMINAL<br>NAME          | NO. | I/O/B† | TYPE‡ | DESCRIPTION                                                                                                                                                                                                         |
|---------------------------|-----|--------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>CLOCK I/O</b>          |     |        |       |                                                                                                                                                                                                                     |
| XTL1_MCLK                 | 20  | I      | A     | Master crystal connection 1 (connects 14.318-MHz crystal) or master clock input (at 14.318 MHz)                                                                                                                     |
| XTL2                      | 22  | O      | A     | Master crystal connection 2 (connects 14.318-MHz crystal)                                                                                                                                                           |
| DATACLK1                  | 54  | O      | D     | 1 <sup>st</sup> clock output: DATACLK1<br>The rising edge of this clock can be used by an external device to clock in THS8083A output data in all modes (see output timing diagrams in Section 4 for more details). |
| ADCCLK2                   | 53  | O      | D     | 2 <sup>nd</sup> clock output: ADCCLK<br>This clock output is equal to the clock of the ADC converter, optionally inverted and/or divided-by-2.                                                                      |
| DTOCLK3                   | 52  | O      | D     | 3 <sup>rd</sup> clock output: DTOCLK.<br>This clock output is the output of the DTO.                                                                                                                                |
| EXT_ADCCLK                | 56  | I      | D     | External clock input for A/D channels, at pixel clock frequency                                                                                                                                                     |
| <b>ANALOG SIGNAL I/O</b>  |     |        |       |                                                                                                                                                                                                                     |
| CH1_IN                    | 81  | I      | A     | Analog input channel 1. Since this channel includes the composite sync slicer and is not downsampled in 4:2:2 mode, this channel should be used for green or luminance input, if any of these features are used.    |
| CH2_IN                    | 88  | I      | A     | Analog input channel 2. In YUV 4:2:2 sampling mode, Pb should be connected to this input to generate a ITU.BT-601 style output.                                                                                     |
| CH3_IN                    | 95  | I      | A     | Analog input channel 3. In YUV 4:2:2 sampling mode, Pr should be connected to this input to generate a ITU.BT-601 style output.                                                                                     |
| VREFBO_CH1                | 82  | B      | A     | Reference voltage bottom output channel 1. In normal operation: output. For a specific configuration, this terminal becomes an input terminal (see Powerdown section in Functional Description).                    |
| VREFTO_CH1                | 83  | B      | A     | Reference voltage top output channel 1. In normal operation it is an output. For a specific configuration, this terminal becomes an input terminal (see Powerdown section in Functional Description).               |
| VREFBO_CH2                | 89  | B      | A     | Reference voltage bottom output channel 2. See VREFBO_CH1.                                                                                                                                                          |
| VREFTO_CH2                | 90  | B      | A     | Reference voltage top output channel 2. See VREFTO_CH1.                                                                                                                                                             |
| VREFBO_CH3                | 96  | B      | A     | Reference voltage bottom output channel 3. See VREFBO_CH1.                                                                                                                                                          |
| VREFTO_CH3                | 97  | B      | A     | Reference voltage top output channel 3. See VREFTO_CH1.                                                                                                                                                             |
| VMID                      | 73  | B      | A     | Midlevel input range (input common mode). In normal operation it is an output. For a specific configuration, this terminal becomes an input terminal (see Powerdown section in Functional Description).             |
| VCM                       | 72  | O      | A     | Common mode voltage output (approximately 1.5 V)                                                                                                                                                                    |
| <b>DIGITAL SIGNAL I/O</b> |     |        |       |                                                                                                                                                                                                                     |
| CH1A0                     | 42  | O      | D     | Display output channel 1, bus A, bit 0 (LSB)                                                                                                                                                                        |
| CH1A1                     | 43  | O      | D     | Display output channel 1, bus A, bit 1                                                                                                                                                                              |
| CH1A2                     | 44  | O      | D     | Display output channel 1, bus A, bit 2                                                                                                                                                                              |
| CH1A3                     | 45  | O      | D     | Display output channel 1, bus A, bit 3                                                                                                                                                                              |
| CH1A4                     | 46  | O      | D     | Display output channel 1, bus A, bit 4                                                                                                                                                                              |
| CH1A5                     | 47  | O      | D     | Display output channel 1, bus A, bit 5                                                                                                                                                                              |
| CH1A6                     | 48  | O      | D     | Display output channel 1, bus A, bit 6                                                                                                                                                                              |
| CH1A7                     | 49  | O      | D     | Display output channel 1, bus A, bit 7 (MSB)                                                                                                                                                                        |
| CH1B0                     | 63  | O      | D     | Display output channel 1, bus B, bit 0 (LSB)                                                                                                                                                                        |
| CH1B1                     | 64  | O      | D     | Display output channel 1, bus B, bit 1                                                                                                                                                                              |

† I = input to device; O = output from device; B = bidirectional

‡ A = analog pin; D = digital pin

## 1.7 THS8083A Terminal Functions Order (Continued)

| TERMINAL<br>NAME                      | NO. | I/O/B† | TYPE‡ | DESCRIPTION                                  |
|---------------------------------------|-----|--------|-------|----------------------------------------------|
| <b>DIGITAL SIGNAL I/O (Continued)</b> |     |        |       |                                              |
| CH1B2                                 | 65  | O      | D     | Display output channel 1, bus B, bit 2       |
| CH1B3                                 | 66  | O      | D     | Display output channel 1, bus B, bit 3       |
| CH1B4                                 | 67  | O      | D     | Display output channel 1, bus B, bit 4       |
| CH1B5                                 | 68  | O      | D     | Display output channel 1, bus B, bit 5       |
| CH1B6                                 | 69  | O      | D     | Display output channel 1, bus B, bit 6       |
| CH1B7                                 | 70  | O      | D     | Display output channel 1, bus B, bit 7 (MSB) |
| CH2A0                                 | 34  | O      | D     | Display output channel 2, bus A, bit 0 (LSB) |
| CH2A1                                 | 35  | O      | D     | Display output channel 2, bus A, bit 1       |
| CH2A2                                 | 36  | O      | D     | Display output channel 2, bus A, bit 2       |
| CH2A3                                 | 37  | O      | D     | Display output channel 2, bus A, bit 3       |
| CH2A4                                 | 38  | O      | D     | Display output channel 2, bus A, bit 4       |
| CH2A5                                 | 39  | O      | D     | Display output channel 2, bus A, bit 5       |
| CH2A6                                 | 40  | O      | D     | Display output channel 2, bus A, bit 6       |
| CH2A7                                 | 41  | O      | D     | Display output channel 2, bus A, bit 7 (MSB) |
| CH2B0                                 | 14  | O      | D     | Display output channel 2, bus B, bit 0 (LSB) |
| CH2B1                                 | 15  | O      | D     | Display output channel 2, bus B, bit 1       |
| CH2B2                                 | 16  | O      | D     | Display output channel 2, bus B, bit 2       |
| CH2B3                                 | 17  | O      | D     | Display output channel 2, bus B, bit 3       |
| CH2B4                                 | 59  | O      | D     | Display output channel 2, bus B, bit 4       |
| CH2B5                                 | 60  | O      | D     | Display output channel 2, bus B, bit 5       |
| CH2B6                                 | 61  | O      | D     | Display output channel 2, bus B, bit 6       |
| CH2B7                                 | 62  | O      | D     | Display output channel 2, bus B, bit 7 (MSB) |
| CH3A0                                 | 26  | O      | D     | Display output channel 3, bus A, bit 0 (LSB) |
| CH3A1                                 | 27  | O      | D     | Display output channel 3, bus A, bit 1       |
| CH3A2                                 | 28  | O      | D     | Display output channel 3, bus A, bit 2       |
| CH3A3                                 | 29  | O      | D     | Display output channel 3, bus A, bit 3       |
| CH3A4                                 | 30  | O      | D     | Display output channel 3, bus A, bit 4       |
| CH3A5                                 | 31  | O      | D     | Display output channel 3, bus A, bit 5       |
| CH3A6                                 | 32  | O      | D     | Display output channel 3, bus A, bit 6       |
| CH3A7                                 | 33  | O      | D     | Display output channel 3, bus A, bit 7 (MSB) |
| CH3B0                                 | 6   | O      | D     | Display output channel 3, bus B, bit 0 (LSB) |
| CH3B1                                 | 7   | O      | D     | Display output channel 3, bus B, bit 1       |
| CH3B2                                 | 8   | O      | D     | Display output channel 3, bus B, bit 2       |
| CH3B3                                 | 9   | O      | D     | Display output channel 3, bus B, bit 3       |
| CH3B4                                 | 10  | O      | D     | Display output channel 3, bus B, bit 4       |
| CH3B5                                 | 11  | O      | D     | Display output channel 3, bus B, bit 5       |
| CH3B6                                 | 12  | O      | D     | Display output channel 3, bus B, bit 6       |
| CH3B7                                 | 13  | O      | D     | Display output channel 3, bus B, bit 7 (MSB) |

† I = input to device: O = output from device B = bidirectional

‡ A = analog pin: D = digital pin

## 1.7 THS8083A Terminal Functions Order (Continued)

| TERMINAL<br>NAME           | NO.                   | I/O/B <sup>†</sup> | TYPE <sup>‡</sup> | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                  |
|----------------------------|-----------------------|--------------------|-------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DIGITAL CONTROL I/O</b> |                       |                    |                   |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| SCL                        | 3                     | B                  | D                 | Clock for I <sup>2</sup> C. Although the device is an I <sup>2</sup> C slave, this signal can be held low by the device to signal contention, therefore it is flagged bidirectional.                                                                                                                                                                                                                                         |
| SDA                        | 4                     | B                  | D                 | Serial data for I <sup>2</sup> C                                                                                                                                                                                                                                                                                                                                                                                             |
| I2CA                       | 5                     | I                  | D                 | Address select for I <sup>2</sup> C<br>0 = LSB of device address 0<br>1 = LSB of device address 1                                                                                                                                                                                                                                                                                                                            |
| EXT_CLP                    | 99                    | I                  | D                 | External clamp timing pulse. Positive polarity required.                                                                                                                                                                                                                                                                                                                                                                     |
| HS                         | 1                     | I                  | D                 | Reference clock input for PLL (horizontal sync input). Polarity selectable via I <sup>2</sup> C register <HS_POL>. 5-V tolerant input                                                                                                                                                                                                                                                                                        |
| VS                         | 2                     | I                  | D                 | Vertical sync input. Polarity selectable via I <sup>2</sup> C register <VS_POL>. 5 V tolerant input                                                                                                                                                                                                                                                                                                                          |
| DHS                        | 55                    | O                  | D                 | Display horizontal sync. This output can be generated as either a delayed version of input HS or as output pulse from the PLL feedback divider. See <i>Display Horizontal Sync</i> section in <i>Functional Description</i> .                                                                                                                                                                                                |
| CS/TEST1                   | 78                    | O                  | A/D               | Composite sync output. This output produces a 3-V logic-compatible sliced output of CH1 or CS_IN, depending on CS_SEL (see CS_IN/TEST2 terminal). When present and enabled, CS carries the embedded composite sync. See <i>Composite Sync Slicer</i> section in <i>Functional Description</i> . For TI internal testing, this pin can also be configured as a test pin. Leave unconnected when CS output signal is not used. |
| CS_IN/TEST2                | 79                    | I                  | A                 | Composite sync slicing input. When selected by CS_SEL register, the signal on this pin is clamped to blanking level according to the clamp timing pulse and sliced approximately 150 mV below this clamped level to produce a composite sync output available on CS/TEST1. This pin can also be configured as a test pin for TI internal testing. Leave unconnected when CS input signal is not used.                        |
| LOCK                       | 100                   | O                  | D                 | Lock detect output<br>0 = unlocked<br>1 = locked                                                                                                                                                                                                                                                                                                                                                                             |
| PFD_FREEZE                 | 98                    | I                  | D                 | Freezes the PLL output frequency by stopping the PFD output (i.e., keeping last increment to DTO). See section 2.3 <i>Composite Sync Slicer</i> .<br>0 = updating<br>1 = frozen                                                                                                                                                                                                                                              |
| $\overline{\text{OE}}$     | 71                    | I                  | D                 | Output enable for data output busses A and B. Data outputs are active only when $\overline{\text{OE}} = \text{L}$ and the corresponding bus is active for the current output formatter mode (register OFM_CTRL). When data outputs are not active or when DVDD = 0 V, data output is Hi-Z. The clock outputs are not affected by $\overline{\text{OE}}$ .<br>0 = enabled<br>1 = disabled                                     |
| $\overline{\text{RESET}}$  | 76                    | I                  | D                 | General chip reset (active low). The reset is a synchronous reset. Therefore, a master clock on XTL1–MCLK needs to be present for proper reset.                                                                                                                                                                                                                                                                              |
| <b>TEST I/O</b>            |                       |                    |                   |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| CS/TEST1                   | 78                    | O                  | A/D               | See previous description for this terminal under DIGITAL CONTROL I/O.                                                                                                                                                                                                                                                                                                                                                        |
| TEST2                      | 79                    | O                  | A/D               | See previous description for this terminal under DIGITAL CONTROL I/O.                                                                                                                                                                                                                                                                                                                                                        |
| SCAN_TEST                  | 77                    | I                  | D                 | Input for scan-path activation:<br>0 = disabled<br>1 = enabled.<br>This pin MUST be tied low for normal operation and is of use for TI internal testing only.                                                                                                                                                                                                                                                                |
| <b>UNUSED PINS</b>         |                       |                    |                   |                                                                                                                                                                                                                                                                                                                                                                                                                              |
| NC                         | 80, 86, 87,<br>93, 94 | I                  | A                 | Not connected. Must be connected to digital ground on the board.                                                                                                                                                                                                                                                                                                                                                             |

<sup>†</sup> I = input to device; O = output from device B = bidirectional

<sup>‡</sup> A = analog pin; D = digital pin

## 2 Functional Description

### 2.1 Analog Channel

The THS8083A contains three identical analog channels that are independently programmable. Each channel consists of a clamping circuit, a programmable gain amplifier, and an A/D converter.

### 2.2 Clamping Circuit

The purpose of clamping is to provide the input signal with a known dc-value. Typically, video signals are ac-coupled into the part. The signal needs to be level-shifted to fall in the reference voltage range (VREFB...VREFT) of the A/D converter. By supplying a programmable clamp, the user can shift the input signal with respect to the A/D range. This has the same effect as keeping the input signal constant and applying offset to both A/D reference voltages while keeping the VREFT–VREFB difference equal. However, no external adjustments are needed with this implementation.

For video, the clamping circuit can only be active during the non-active video portion of each line to avoid changes in brightness along the line. Clamping is done during the horizontal blanking interval, either on the back porch of sync or during the sync tip (in the case of a sync present on at least one of the video channels). If HS is carried on a separate line, as is typically the case for PC graphics, clamping is done during blanking. When the Y or G input channel contains an embedded sync, then alternatively clamping can be done during the sync-tip or during the front or back porch of sync. Only clamping during front- or back-porch of sync is supported on the THS8083A, since it is expected that the input signal level during clamping, of which position and width are determined by the clamp timing pulse (as shown later) corresponds to the blanking level. Since the blanking level for RGB type inputs corresponds to a low output code of the A/D, it makes sense to center the clamp range around an A/D output code of 0. The user can adjust this level up or down, symmetrically around 0. If the clamping is set such that the blanking level corresponds to a level below 0, the A/D output is clipped at code 0.

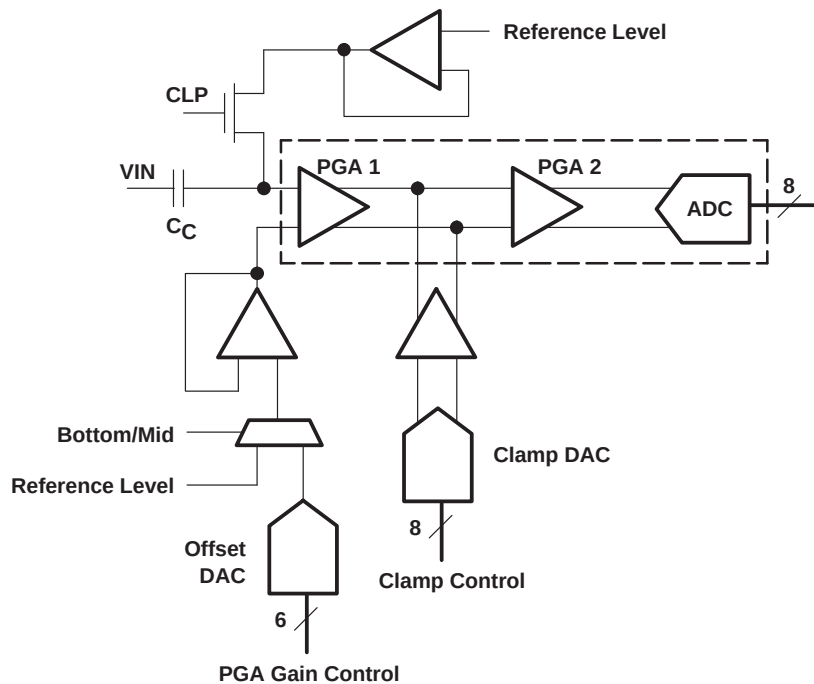


Figure 2-1. Analog Channel Architecture

In the case of YUV input signals, blanking levels for U and V correspond to the mid-level analog input. To handle these signals the clamping range should be centered on the mid-level output code of the A/D.

The clamp code is 8 bits wide and spans 128 ADC output codes (a 2 LSB change to clamp code corresponds nominally to 1 LSB change in ADC output). The programmed clamp code is independent of the PGA setting (see later). This ensures independent brightness/clamping control.

The clamp pulse defines the timing window during which the clamp circuit is internally enabled, and is either generated externally and supplied to the device, or it can be internally generated. In the latter case, the user can program both the position and width of the clamp pulse with respect to the horizontal sync (HS) input.

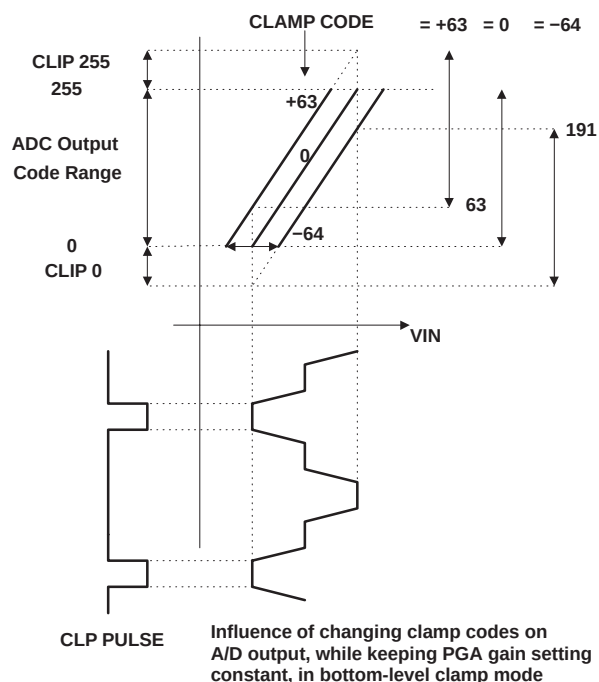


Figure 2-2. Bottom-Level Clamping

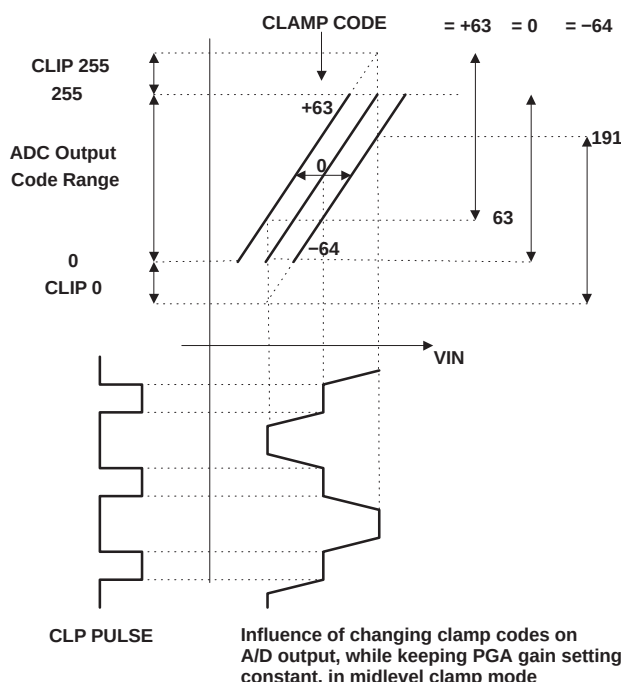


Figure 2-3. Mid-Level Clamping

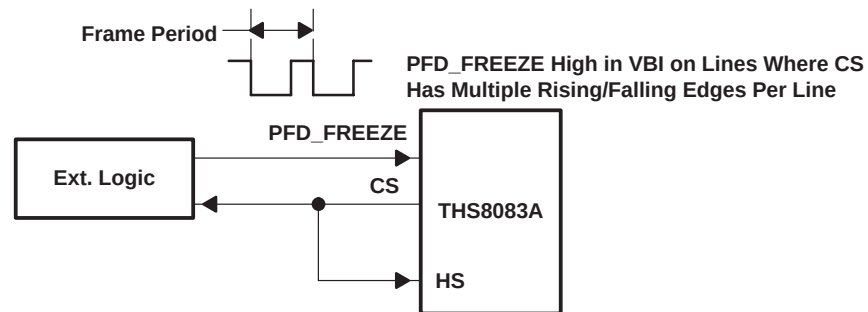
## 2.3 Composite Sync Slicer

The THS8083A includes a circuit that compares the input signal on Ch.1, or on the dedicated CS\_IN input, to a level 150 mV below the blanking level. This slicer outputs a 3-V compatible digital output on the composite sync (CS) pin. The intended use of this circuit is for input video signals that have an embedded (negative or trilevel) sync. This is the case for workstation-type input signals or the DTV analog interface that mandates sync-on-Y. Since the sync amplitude is ~300 mV, the slicing level is at about 50% of the sync level. When enabled, the CS output is available even when the device is powered down.

CS outputs the extracted composite sync. Since the PLL is prevented from updating its phase detector while the PFD\_FREEZE pin is kept high, the user asserts PFD\_FREEZE during the VBI (when CS has multiple transitions per line). This puts the PLL in free-run. While it cannot be assured with devices that have analog PLL's, the digital PLL in the THS8083A is assured to keep a constant output frequency and avoid frequency drift while the PLL is in free-run. There is also no maximum on the time that PFD\_FREEZE can be kept asserted to still keep a stable PLL output frequency. In this case, the CS output can be directly connected to the THS8083A's HS input for purposes of locking the PLL. However, the frequency monitoring of HS, which works off signal edges, produces invalid numbers on those lines where CS is present because of the multiple low-high transitions on these lines.

Alternatively, if an external sync separator is present that generates HS and VS from CS, the separated signals can be fed to the corresponding inputs on the THS8083A and PFD\_FREEZE can be left unused. As long as HS has one pulse per line, the PLL can lock correctly and the HS frequency monitoring register will return the correct value. VS is only used by the field/frame frequency monitoring register and this will return the correct value as long as VS has one pulse per field/frame. Both options are shown in Figure 2–4.

**Option 1: Using PFD\_FREEZE**



**Option 2: Using HS Derived From CS**

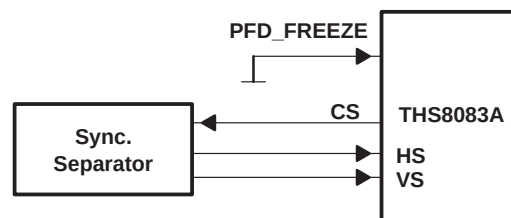


**Figure 2–4. Using THS8083A With a Composite Sync**

as Note that the slicer only works when no video levels are lower than the blanking level and when the internal clamp circuit is used. This is normally satisfied for G and Y channels, but not for U and V channels. To prevent unnecessary toggling of the CS output signal, the CS output is switched off (i.e. HI-Z) automatically when mid-level clamping is chosen for channel 1 (i.e., CLP1\_RG=1 in register <CLP\_CTRL>).

The source for the slicer is either Ch1 or the dedicated input CS\_IN, as selected by register CS\_SEL. It is recommended to use the dedicated input by ac-coupling the Y/G signal input to both Ch1 and CS\_IN (using independent coupling capacitors). The THS8083A performs independent clamping on both inputs.

**NOTE:**In this revision-A silicon, PDF\_FREEZE keeps the DTO output frequency constant and disables the phase-frequency detector (PFD) from internally updating its error value at every active edge of HS (this was not the case in prerevision-A versions). Therefore, when PFD\_FREEZE is asserted, the PLL effectively ignores incoming pulses on the HS terminal.

In this revision-A silicon, users do not need to provide an external dc biasing to the Y/G channel since now a dedicated input terminal for composite sync slicing is provided. This was not the case in prerevision-A versions, where the sync could only be extracted from Channel1 and a clamp diode had to be used to establish an initial clamping level. This method is described in the following section.

When using the dedicated CS\_IN terminal, the G/Y signal should be ac-coupled to this terminal independently from Ch1, i.e., the G/Y signal is routed via a coupling capacitor to CS\_IN and via a second coupling capacitor to Ch1. This is because the THS8083A imposes an independent (programmable) clamp level for the sync input.

### 2.3.1 Implementation When Using Channel 1 Sync Slicing From Ch1 as Selected by CS\_SEL, or on Prerevision A Silicon

To support sync-on-Y/sync-on-G extraction, users should provide an external dc biasing to the Y/G channel. This can be done by establishing a dc clamp through a diode with its cathode connected to the ac-coupling capacitor (at the side of the THS8083A) on the AGY channel and its anode connected to a dc level. Since the slicing level is approximately 1.35 V and the sync amplitude is -300 mV, the negative sync-tip should be clamped by the diode to a level of approximately 1.2 V. For example, using a Schottky switching diode (type 1N5711) with a maximum low forward voltage drop of 0.4 V, the dc level at the anode can be approximately 1.6 V. This level can be derived through a resistive voltage divider off the power supply.

## 2.4 Programmable Gain Amplifier (PGA)

Each video channel is passed through a programmable gain amplifier, to provide a full-scale signal to each A/D. The user can change this gain via register programming. A gain change becomes effective immediately.

The range of the PGA is such that an input ac range from 0.4 Vpp to 1.2 Vpp can be scaled to ADC full scale, by maximum gain and minimum gain settings respectively.

The PGA is split into a 6-bit coarse gain control and 5-bit fine gain control. Their combination leads to a PGA resolution of better than 1 LSB on the ADC output code.

The bandwidth of the PGA is by design constant, resulting in a constant analog video input bandwidth.

The coarse PGA, with its 64 settings, covers a  $4/3 \times$  to  $4 \times$  gain change, used for a 0.4 V ( $0.4 \text{ Vpp} \times 4 = 1.6 \text{ Vpp}$ ) respectively 1.2 Vpp ( $1.2 \text{ Vpp} \times 4/3 = 1.6 \text{ Vpp}$ ) input range swing.

While an amplifier with variable gain implements the coarse PGA, the fine PGA is implemented by slightly changing the top and bottom reference levels that are also independently controllable for each ADC channel. The fine range, with its 32 settings, covers a range of 16 LSBs.

The fine and coarse PGA settings can be combined into a single PGA gain formula as follows:

$$\text{GAIN} = (4/3 + C/24)(1 + (F-15)/512)$$

Where C is the coarse gain setting (0..63) and F the fine gain setting (0..31).

## 2.5 A/D Converter

The A/D converter's switched-capacitor single-pipeline CMOS architecture combines excellent signal-to-noise characteristics with a very wide 3-dB analog input bandwidth of typically 500 MHz. The A/D block contains an internal reference voltage generator, providing stable bottom and top references derived from an internal bandgap reference. The reference voltages are made available externally. The THS8083A supports both dc and ac-coupled inputs (clamping disabled). With dc-coupling, available external references can be used to level-shift the input signal.

The A/D converter is assured up to 80 MSPS with no missing codes. The sampling clock of the A/D converter is either externally fed or internally generated by the PLL.

## 2.6 PLL

The PLL is a fully contained functional block consisting of:

- An analog PLL operating at a fixed output frequency of N times the master (crystal) clock frequency
- A digital PLL containing a digital phase-frequency detector (PFD), a discrete time oscillator (DTO), a digital loop filter, a feedback divider, a programmable clock output divider, and a programmable phase shifter

### 2.6.1 Analog PLL

The analog PLL generates a high-frequency internal clock used by the DTO in the digital PLL to derive the pixel output frequency with programmable phase. The reference signal for this PLL is the master clock frequency supplied on the XTL1-MCLK terminal.

Two options exist for connecting a master clock:

- A crystal can be connected between the XTL1-MCLK and XTL2 terminals. The device provides internal oscillator circuitry.
- A 3.3-V CMOS/TTL clock signal can be connected to XTL1-MCLK from an external oscillator. In this case XTL2 must be left unconnected.

The port is designed to operate from a master clock frequency of 14.31818 MHz, which is a standard frequency in video applications: 4x is the subcarrier frequency for NTSC. Many low-cost crystals are available for this frequency. The default internal oscillator operates at 8x the master clock frequency, or about 114 MHz. This setting of 8x, which is the value of the feedback divider in the analog PLL loop, is programmable (VCODIV register value). Normally this remains as the default 8x value. Users can change this value when a master clock of a different frequency is connected. In this case care should be taken to keep the internal high-frequency clock (i.e., master clock frequency x analog feedback divider) lower than 120 MHz. The higher this internal frequency, the better the frequency resolution of the DTO.

When a crystal is used as the master clock source, it is not advised to use another frequency than the recommended 14.31818 MHz, since the internal oscillator circuitry is not production tested at other frequencies. If another master clock is used, it is recommended to drive XTL1-MCLK by a direct clock signal. VCODIV should be programmed such that the internal clock remains close to but less than 120 MHz.

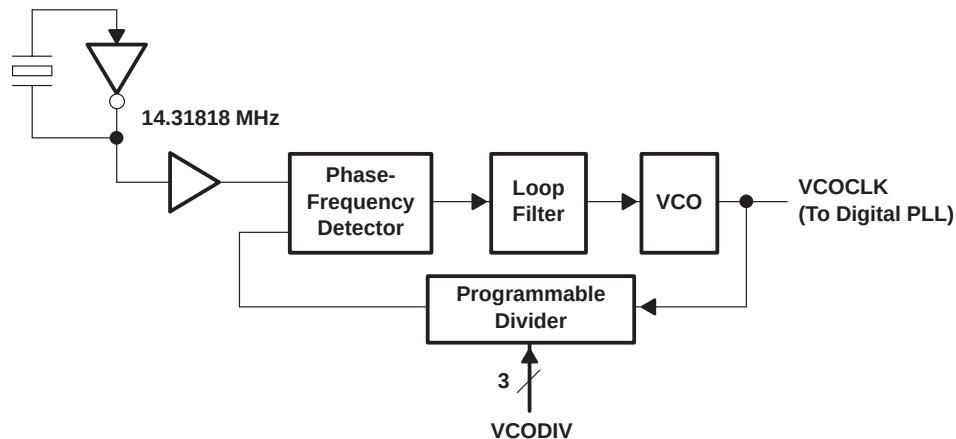


Figure 2-5. Analog PLL

## 2.6.2 Digital PLL

The digital PLL loop derives the ADC (pixel) clock frequency from the high-speed internal clock. A DTO generates an output frequency from a user-programmable DTO increment. To operate over the 13–80 MHz range, an extra DTO clock output divider can be switched in. Appendix A shows the formula that relates the frequency of the internal high-speed clock, the DTO increment value, and the DTO clock output divider to the PLL output frequency.

The PLL output, after the clock divider, is sent to the programmable feedback divider (TERM\_CNT register value). This value is typically programmed with the number of total pixels per line for a given video/graphics format. The output of this divider is then one input to the phase-frequency detector. Its other input is typically the horizontal sync (HS) reference of a graphics/video signal. HS needs to be provided as a separate TTL/CMOS type signal to the dedicated input terminal. See the *Composite Sync Slicer* section to use the PLL in the case of input signals with a composite sync. The polarity of HS is programmable (HS\_POL register value).

Both HS and VS inputs on the THS8083A can accept a 3-V and a 5-V logic-compliant signal.

On the HS input, as on the VS input, a digital noise gate can be optionally switched in (HS\_MS and VS\_MS register values, respectively). The user can program the minimum number of clock cycles that have to be present in HS and VS before they are interpreted as a valid HS and VS. This avoids having any spikes being interpreted as an active HS and falsely updating the PLL.

The PFD produces a digital error value, signaling the phase/frequency difference between the HS input and the divided PLL output clock. The integrated digital PLL loop filter subsequently filters this error value. This filter consists of proportional and integrator (accumulator) parts. Gains of both parts are programmable (GAIN\_N and GAIN\_P register values), each with eight settings. The higher the programmed value, the higher the gain in either the proportional or integrator portions of the filter, which translates into a wider capture range and faster acquisition but also into higher steady-state jitter.

The PFD also provides a LOCK output on a dedicated terminal. This output has programmable hysteresis (LD\_THRES register value). Details are explained in the *Register Description* section. The LOCK output is made available on a dedicated pin so that the user could implement additional functionality before using this output (e.g., implement the *sticky* nature of an unlock condition by routing it through an external set/reset flip-flop).

By integrating the loop filter and making it programmable, the user can trade off both at runtime depending on the quality of the incoming HS signal (inaccurate frequency, jitter content).

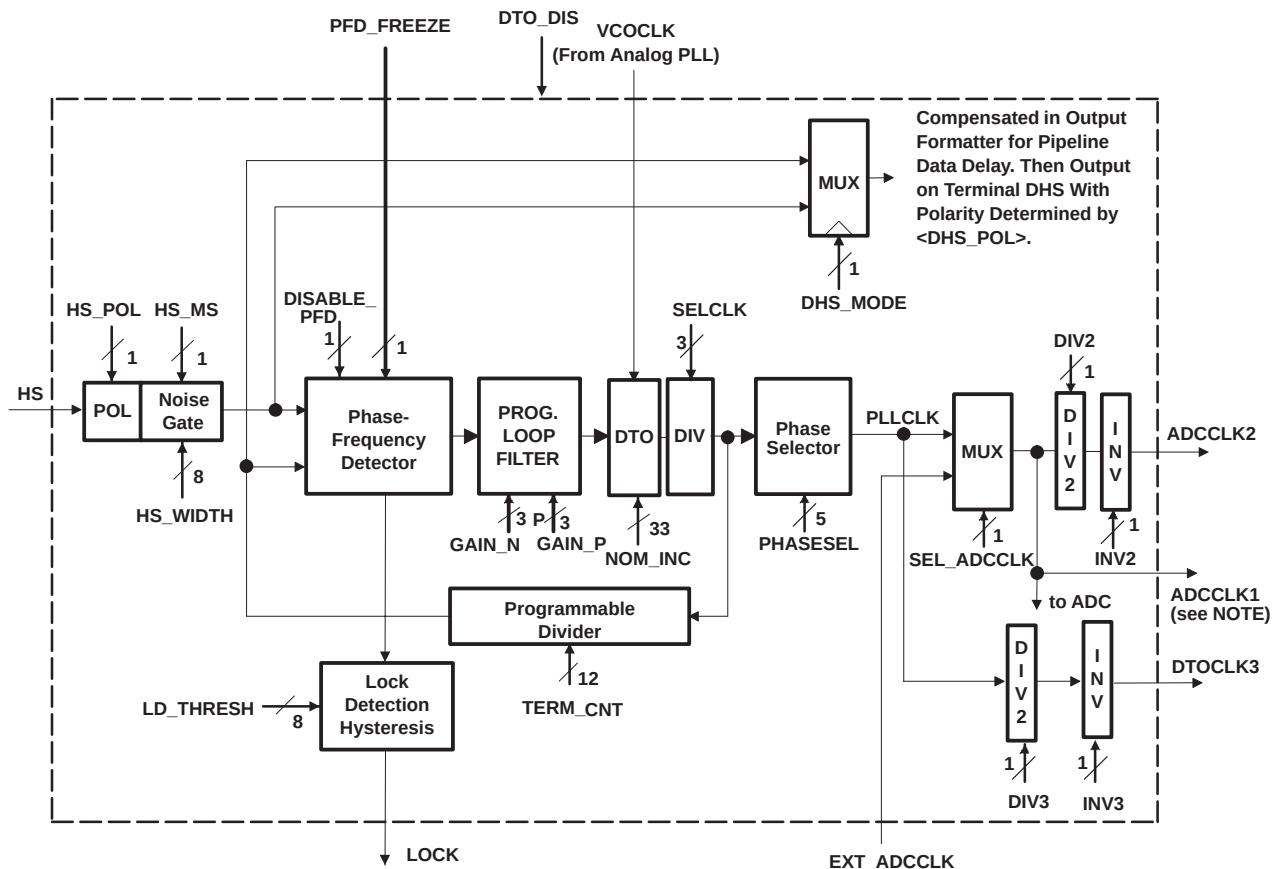
The filtered phase/frequency *error* value is now used to correct the programmed *nominal* DTO increment (NOM\_INC register value). This updated DTO increment (DTO\_INC register value) is used by the DTO and determines the instantaneous DTO output frequency. By making DTO\_INC available as a read-only register, the user can read out via I<sup>2</sup>C and calculate the instantaneous frequency of the DTO-generated clock.

Because of the digital nature of the PLL, the loop can be opened while still keeping an accurate frequency output. Therefore, the PLL can also be used as a frequency synthesizer without any HS reference. This is done by disabling the PFD (PFD\_DISABLE register value). This keeps DTO\_INC always equal to NOM\_INC, thereby producing a DTO output frequency always equal to the desired programmed frequency, irrespective of HS.

There is a second option to operate in open loop. In some video/graphics modes, no valid HS is present during a part of the frame/field period, typically during some lines of the VBI (vertical blanking interval). In order to have an accurate PLL output clock and avoid clock drift, the PFD output needs to be held constant during this time. The PFD FREEZE pin provides this option. Asserting this pin freezes DTO\_INC to its present value, thereby producing a constant PLL output clock frequency, not necessarily equal to the nominal desired frequency programmed by NOM\_INC. Together with the composite sync slicer, this feature allows using the PLL with input signals containing embedded composite sync with minimal external logic. See the *Composite Sync Slicer* section.

The phase of the PLL generated clock can be programmed in 31 uniform steps over a single clock period ( $360/31 = 11.6$  degrees phase resolution) so that the sampling phase of the ADC can be accurately controlled.

In addition to sourcing the ADC channel clock from the PLL, an external pixel clock can be used (from terminal EXT\_ADCCLK). If configured this way (via SEL\_ADCCLK register value), a clock signal of the required sampling frequency should be applied to EXT\_ADCCLK; this signal, instead of the PLL generated clock, is routed to the ADC channels. In this case no phase control is available on the external clock signal. Still, the internal PLL can be used and its output made available externally as explained below. This means two clock domains can be implemented on the THS8083A: one is externally fed, and the other, possibly asynchronous to the first, generated by the internal PLL. This provides considerable flexibility in the design of video/graphics equipment that implements scaling and frame rate conversion.



NOTE: ADCCLK1 is used by the output formatter to generate the DATACLK1 output.

**Figure 2-6. Digital PLL**

The device provides three clock outputs. One output signal, DATACLK1, is derived from the ADC clock output. It is actually equal to the sampling clock, but compensated in phase so that its rising edge always corresponds to the center valid region of the output data. Output data timing (setup/hold) is specified with respect to this rising edge. Therefore, DATACLK1 is typically used for clocking the THS8083A's output data. The frequency of DATACLK1 is either equal to, or one half the sampling clock, depending on the operation mode of the output formatter. When the THS8083A is clocked with an external sampling clock, this external clock is used as the source to generate DATACLK1 in the output formatter.

The second clock output, ADCCLK2, is equal to the ADC sampling clock, but can optionally be divided by 2 and inverted.

The third clock output, DTOCLK3, is always derived from the PLL output clock, irrespective of the use of an external sampling clock on EXT\_ADCCLK. So, when operating with an external sampling clock, the DTOCLK3 output can be used to generate a second, possibly asynchronous, clock signal in either open or closed loop operation locked to a reference HS input. Also, DTOCLK3 can be optionally divided by 2 and inverted.

The divide and invert functions are implemented to enable a two-part master/slave operation in case sampling speeds higher than 80 MSPS are required. In this case, the master uses its PLL to generate a line-locked clock, and its inverse is used by the second slave device as an external sampling clock.

## 2.7 Output Formatter

This block enables either a 4:4:4 24-bit output or a 4:4:4 48-bit output at half the pixel clock, or a 4:2:2 16-bit output useful for YUV digitizing (ITU.BT-601 style). In the latter case, an 8-bit port is used for the Y output while a second 8-bit port is used alternately for Cr or Cb. As per ITU BT-601, Cb is the first video data word for each line, as shown in Figure 2-7.

The first color sample after an incoming HS is Cb. The output signal DHS is synchronized to the first pixel of a line and can therefore be used to uniquely identify Cb from Cr output data in down-sampled modes.

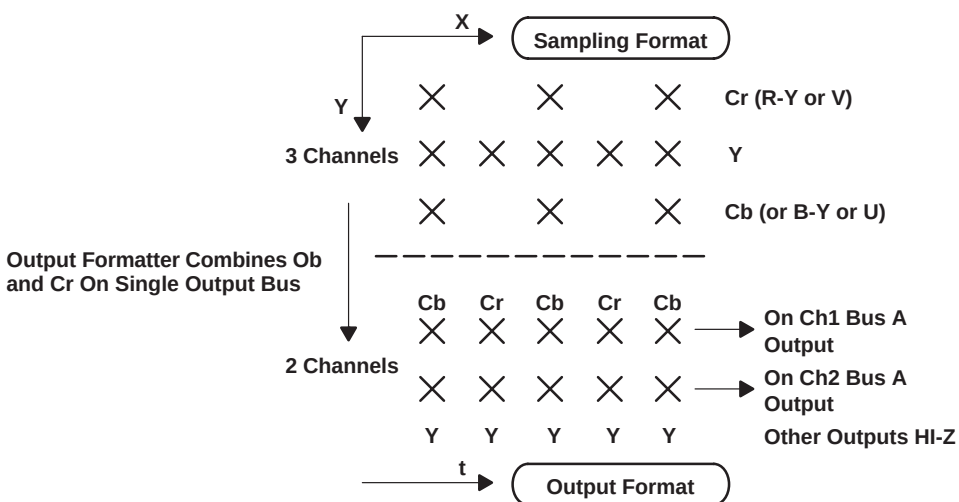


Figure 2-7. Output Formatter

## 2.8 Power Down

Three power down modes are defined in the I<sup>2</sup>C power-down register, :

- Chip power down: PWDN\_ALL  
When PWDN\_ALL=1, all analog circuits are powered down except the internal bandgap reference, the circuit that generates the clamping voltages and the sync reference voltage. All these are kept active for the composite sync slicer that remains active during power down. The clock frequency of the digital circuitry is lowered to reduce power consumption when in power down.
- Internal reference power down: PWDN\_REF  
When PWDN\_REF=1, bottom and top references (VREFB, VREFT) on all channels become inputs and should be externally driven.
- Bandgap reference power down: PWDN\_BGAP  
When PWDN\_BGAP=1, the internal bandgap reference voltage is inactive and terminal VMID should be externally driven.

Additionally, the DTO circuitry can be disabled:

- DTO power down: DTO\_DIS  
When DTO\_DIS=1, the DTO frequency is lowered to reduce power dissipation. This feature can be activated when an external sampling clock is used (EXT\_ADCCLK).

## 2.9 Input Mode Detection

The THS8083A supports detection of the graphics input format in cooperation with an external microcontroller. Via the microcontroller interface, the period of incoming HS and VS signals (HS\_COUNT, VS\_COUNT register values), the frequency of the DTO clock (DTO\_INC register value), and the PLL lock condition (terminal LOCK) can be measured.

## 2.10 ADC Readback Over I<sup>2</sup>C Interface

The ADC output data on each of the three channels can be sampled at a programmable position on each line (PIXTRAP register value) and latched into pixel readback registers (CH<n>\_RDBK register values) that can be read by the microcontroller at lower speed via the I<sup>2</sup>C interface. Programming to read back during the horizontal blanking interval can be a test for accurate positioning of the blanking level.



## 3 Register Definition

### 3.1 I<sup>2</sup>C Protocol

The THS8083A is a slave I<sup>2</sup>C device that supports both write and read. As shown in Table 3–1, *I<sup>2</sup>C Register Map*, there are some status control registers that can only be read.

The device can support FAST I<sup>2</sup>C mode (SCL up to 400 kHz) when the DTO clock is running at over 25 MHz; at lower DTO frequencies, only NORMAL I<sup>2</sup>C mode (SCL up to 100 kHz) is supported.

To discriminate between write and read operations, the device is addressed at separate device addresses. There is an automatic internal subaddress increment counter to efficiently write/read multiple bytes in the register map during one write/read operation. Furthermore, bit 1 of the I<sup>2</sup>C device address is dependent upon the I2CA pin setting, as follows:

If address selecting pin I2CA = 0, then

Write address is 40 hex (01000000)

Read address is 41 hex (01000001)

If address selecting pin I2CA = 1, then

Write address is 42 hex (01000010)

Read address is 43 hex (01000011)

#### 3.1.1 Write Format

|   |                  |   |            |   |       |   |       |           |   |   |
|---|------------------|---|------------|---|-------|---|-------|-----------|---|---|
| S | Slave address(w) | A | Subaddress | A | Data0 | A | ..... | Data(N–1) | A | P |
|---|------------------|---|------------|---|-------|---|-------|-----------|---|---|

|                  |                                                       |
|------------------|-------------------------------------------------------|
| S                | Start condition                                       |
| Slave address(w) | 0100000 (0x40) if I2CA=0 / 01000010 (0x42) if I2CA=1  |
| A                | Acknowledge. It is generated by THS8083A.             |
| Subaddress       | Subaddress of first register to write, length: 1 byte |
| Data0            | First byte of data                                    |
| Data(N–1)        | Nth byte of data                                      |
| P                | Stop condition                                        |

3.1.2 Read Format

First write the subaddress, where data needs to be read out, to the THS8083A in the following format:

|   |                  |   |            |   |   |
|---|------------------|---|------------|---|---|
| S | Slave address(w) | A | Subaddress | A | P |
|---|------------------|---|------------|---|---|

Then:

|   |                  |   |       |    |           |    |       |     |   |
|---|------------------|---|-------|----|-----------|----|-------|-----|---|
| S | Slave address(r) | A | DataN | AM | Data(N+1) | AM | ..... | NAM | P |
|---|------------------|---|-------|----|-----------|----|-------|-----|---|

|                  |                                                                                                |
|------------------|------------------------------------------------------------------------------------------------|
| S                | Start condition                                                                                |
| Slave address(r) | 01000001 (0x41) if I2CA=0 / 01000011 (0x43) if I2CA=1                                          |
| A                | Acknowledge, generated by the THS8083A. If transmission is successful, then A = 0, else A = 1. |
| AM               | Acknowledge, generated by a master                                                             |
| NAM              | Not acknowledge, generated by a master                                                         |
| Subaddress       | Subaddress of the first register to read, length = one byte                                    |
| Data0            | First byte of the data read                                                                    |
| Data(N-1)        | Nth byte of the data read                                                                      |
| P                | Stop condition                                                                                 |

In both write and read operations, the subaddress is incremented automatically when multiple bytes are written/read. So, only the first subaddress needs to be supplied to the THS8083A.

R/W registers can be written and read.

R registers are read-only.

**Table 3-1. I<sup>2</sup>C Register Map**

| REGISTER NAME | R/W | SUB ADDRESS | Bit 7     | Bit 6     | Bit 5       | Bit 4      | Bit 3      | Bit 2      | Bit 1      | Bit 0      |
|---------------|-----|-------------|-----------|-----------|-------------|------------|------------|------------|------------|------------|
| TERM_CNT_0    | R/W | 00          | TERM_CNT7 | TERM_CNT6 | TERM_CNT5   | TERM_CNT4  | TERM_CNT3  | TERM_CNT2  | TERM_CNT1  | TERM_CNT0  |
| TERM_CNT_1    | R/W | 01          |           |           |             |            | TERM_CNT11 | TERM_CNT10 | TERM_CNT9  | TERM_CNT8  |
| NOM_INC_0     | R/W | 02          | NOM_INC7  | NOM_INC6  | NOM_INC5    | NOM_INC4   | NOM_INC3   | NOM_INC2   | NOM_INC1   | NOM_INC0   |
| NOM_INC_1     | R/W | 03          | NOM_INC15 | NOM_INC14 | NOM_INC13   | NOM_INC12  | NOM_INC11  | NOM_INC10  | NOM_INC9   | NOM_INC8   |
| NOM_INC_2     | R/W | 04          | NOM_INC23 | NOM_INC22 | NOM_INC21   | NOM_INC20  | NOM_INC19  | NOM_INC18  | NOM_INC17  | NOM_INC16  |
| NOM_INC_3     | R/W | 05          | NOM_INC31 | NOM_INC30 | NOM_INC29   | NOM_INC28  | NOM_INC27  | NOM_INC26  | NOM_INC25  | NOM_INC24  |
| NOM_INC_4     | R/W | 06          |           |           |             |            |            |            |            | NOM_INC32  |
| VCODIV        | R/W | 07          |           |           |             |            |            | VCODIV2    | VCODIV1    | VCODIV0    |
| SELCLK        | R/W | 08          |           |           |             |            |            |            | SELCLK1    | SELCLK0    |
| PHASESEL      | R/W | 09          |           |           |             | PHASE_SEL4 | PHASE_SEL3 | PHASE_SEL2 | PHASE_SEL1 | PHASE_SEL0 |
| PLLFILT       | R/W | 0A          |           |           | GAIN_N2     | GAIN_N1    | GAIN_N0    | GAIN_P2    | GAIN_P1    | GAIN_P0    |
| HS_WIDTH      | R/W | 0B          | HS_WIDTH7 | HS_WIDTH6 | HS_WIDTH5   | HS_WIDTH4  | HS_WIDTH3  | HS_WIDTH2  | HS_WIDTH1  | HS_WIDTH0  |
| VS_WIDTH      | R/W | 0C          | VS_WIDTH7 | VS_WIDTH6 | VS_WIDTH5   | VS_WIDTH4  | VS_WIDTH3  | VS_WIDTH2  | VS_WIDTH1  | VS_WIDTH0  |
| SYNC_CTRL     | R/W | 0D          |           |           |             |            | HS_POL     | HS_MS      | VS_POL     | VS_MS      |
| LD_THRES      | R/W | 0E          | LD_THRES7 | LD_THRES6 | LD_THRES5   | LD_THRES4  | LD_THRES3  | LD_THRES2  | LD_THRES1  | LD_THRES0  |
| PLL_CTRL      | R/W | 0F          |           |           | DISABLE_PFD | SEL_ADCCLK | INV2       | DIV2       | INV3       | DIV3       |
| HS_COUNT_0    | R   | 10          | HS_COUNT7 | HS_COUNT6 | HS_COUNT5   | HS_COUNT4  | HS_COUNT3  | HS_COUNT2  | HS_COUNT1  | HS_COUNT0  |
| HS_COUNT_1    | R   | 11          |           |           |             |            | HS_COUNT11 | HS_COUNT10 | HS_COUNT9  | HS_COUNT8  |
| VS_COUNT_0    | R   | 12          | VS_COUNT7 | VS_COUNT6 | VS_COUNT5   | VS_COUNT4  | VS_COUNT3  | VS_COUNT2  | VS_COUNT1  | VS_COUNT0  |
| VS_COUNT_1    | R   | 13          |           |           |             |            | VS_COUNT11 | VS_COUNT10 | VS_COUNT9  | VS_COUNT8  |
| DTO_INC_0     | R   | 14          | DTO_INC7  | DTO_INC6  | DTO_INC5    | DTO_INC4   | DTO_INC3   | DTO_INC2   | DTO_INC1   | DTO_INC0   |
| DTO_INC_1     | R   | 15          | DTO_INC15 | DTO_INC14 | DTO_INC13   | DTO_INC12  | DTO_INC11  | DTO_INC10  | DTO_INC9   | DTO_INC8   |
| DTO_INC_2     | R   | 16          | DTO_INC23 | DTO_INC22 | DTO_INC21   | DTO_INC20  | DTO_INC19  | DTO_INC18  | DTO_INC17  | DTO_INC16  |
| DTO_INC_3     | R   | 17          | DTO_INC31 | DTO_INC30 | DTO_INC29   | DTO_INC28  | DTO_INC27  | DTO_INC26  | DTO_INC25  | DTO_INC24  |
| DTO_INC_4     | R   | 18          |           |           |             |            |            |            |            | DTO_INC32  |
| SYNC_DETECT   | R   | 19          |           |           |             |            |            |            |            | NO_SYNC    |
| Reserved      |     | 1A-1F       |           |           |             |            |            |            |            |            |

NOTE: Blank register bits in this table are ignored upon write. When read they return 0.

Table 3-1. I<sup>2</sup>C Register Map (continued)

| REGISTER NAME | R/W | SUB ADDRESS | Bit 7      | Bit 6      | Bit 5       | Bit 4       | Bit 3       | Bit 2       | Bit 1       | Bit 0       |
|---------------|-----|-------------|------------|------------|-------------|-------------|-------------|-------------|-------------|-------------|
| CLP_CTRL      | R/W | 20          |            | CLP_SEL    | CLP1_EN     | CLP1_RG     | CLP2_EN     | CLP2_RG     | CLP3_EN     | CLP3_RG     |
| CLP_START_0   | R/W | 21          | CLP_START7 | CLP_START6 | CLP_START5  | CLP_START4  | CLP_START3  | CLP_START2  | CLP_START1  | CLP_START0  |
| CLP_START_1   | R/W | 22          |            |            |             |             | CLP_START11 | CLP_START10 | CLP_START9  | CLP_START8  |
| CLP_STOP_0    | R/W | 23          | CLP_STOP7  | CLP_STOP6  | CLP_STOP5   | CLP_STOP4   | CLP_STOP3   | CLP_STOP2   | CLP_STOP1   | CLP_STOP0   |
| CLP_STOP_1    | R/W | 24          |            |            |             |             | CLP_STOP11  | CLP_STOP10  | CLP_STOP9   | CLP_STOP8   |
| CH1_CLP       | R/W | 25          | CH1_CLP7   | CH1_CLP6   | CH1_CLP5    | CH1_CLP4    | CH1_CLP3    | CH1_CLP2    | CH1_CLP1    | CH1_CLP0    |
| CH1_COARSE    | R/W | 26          |            |            | CH1_COARSE5 | CH1_COARSE4 | CH1_COARSE3 | CH1_COARSE2 | CH1_COARSE1 | CH1_COARSE0 |
| CH1_FINE      | R/W | 27          |            |            |             | CH1_FINE4   | CH1_FINE3   | CH1_FINE2   | CH1_FINE1   | CH1_FINE0   |
| CH2_CLP       | R/W | 28          | CH2_CLP7   | CH2_CLP6   | CH2_CLP5    | CH2_CLP4    | CH2_CLP3    | CH2_CLP2    | CH2_CLP1    | CH2_CLP0    |
| CH2_COARSE    | R/W | 29          |            |            | CH2_COARSE5 | CH2_COARSE4 | CH2_COARSE3 | CH2_COARSE2 | CH2_COARSE1 | CH2_COARSE0 |
| CH2_FINE      | R/W | 2A          |            |            |             | CH2_FINE4   | CH2_FINE3   | CH2_FINE2   | CH2_FINE1   | CH2_FINE0   |
| CH3_CLP       | R/W | 2B          | CH3_CLP7   | CH3_CLP6   | CH3_CLP5    | CH3_CLP4    | CH3_CLP3    | CH3_CLP2    | CH3_CLP1    | CH3_CLP0    |
| CH3_COARSE    | R/W | 2C          |            |            | CH3_COARSE5 | CH3_COARSE4 | CH3_COARSE3 | CH3_COARSE2 | CH3_COARSE1 | CH3_COARSE0 |
| CH3_FINE      | R/W | 2D          |            |            |             | CH3_FINE4   | CH3_FINE3   | CH3_FINE2   | CH3_FINE1   | CH3_FINE0   |
| PIX_TRAP_0    | R/W | 2E          | PIX_TRAP7  | PIX_TRAP6  | PIX_TRAP5   | PIX_TRAP4   | PIX_TRAP3   | PIX_TRAP2   | PIX_TRAP1   | PIX_TRAP0   |
| PIX_TRAP_1    | R/W | 2F          |            |            |             |             | PIX_TRAP11  | PIX_TRAP10  | PIX_TRAP9   | PIX_TRAP8   |
| PWDN_CTRL     | R/W | 30          |            |            |             | PWDN_ALL    |             | PWDN_REF    | PWDN_BGAP   | DTO_DIS     |
| AUX_CTRL      | R/W | 31          |            |            | CS_SEL      | CS_DIS      | TEST2       | TEST1       | TEST0       | TACT        |
| CH1_RDBK      | R   | 32          | CH1_RDBK7  | CH1_RDBK6  | CH1_RDBK5   | CH1_RDBK4   | CH1_RDBK3   | CH1_RDBK2   | CH1_RDBK1   | CH1_RDBK0   |
| CH2_RDBK      | R   | 33          | CH2_RDBK7  | CH2_RDBK6  | CH2_RDBK5   | CH2_RDBK4   | CH2_RDBK3   | CH2_RDBK2   | CH2_RDBK1   | CH2_RDBK0   |
| CH3_RDBK      | R   | 34          | CH3_RDBK7  | CH3_RDBK6  | CH3_RDBK5   | CH3_RDBK4   | CH3_RDBK3   | CH3_RDBK2   | CH3_RDBK1   | CH3_RDBK0   |
| Reserved      |     | 35-3F       |            |            |             |             |             |             |             |             |
| OFM_CTRL      | R/W | 40          |            |            |             |             | DHS_MODE    | DHS_POL     | OFM_MODE1   | OFM_MODE0   |

NOTE: Blank register bits in this table are ignored upon write. When read they return 0.

## 3.2 Register Description

**Register values after reset/at power up/after power down mode:** The default value with each register shows the start-up condition after general chip reset. The register state after power up is undefined i.e., the device requires a reset after power up (RESET low) to put all registers in their default states. The value of these registers is preserved in all power-down modes (i.e. after power down the register values are identical as when entering power down); they do not return to their default values under this condition. In order for the device to reset correctly, a master clock signal needs to be applied during reset from either a clock signal on XTL1–MCLK or a crystal connected between XTL1–MCLK and XTL2. The reset signal needs to be at least 5 clock cycles wide.

**Default values:** The default values for this device are set for XGA@78.75 MHz.

### 3.2.1 Register Name: TERM\_CNT\_0

**Subaddress: 00 (R/W)**

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| TERM_CNT7 | TERM_CNT6 | TERM_CNT5 | TERM_CNT4 | TERM_CNT3 | TERM_CNT2 | TERM_CNT1 | TERM_CNT0 |

TERM\_CNT[7..0]:

TERM\_CNT[11..0] sets the number of pixels per line. Controls the digital PLL feedback divider.  
Default: 0x20

### 3.2.2 Register Name: TERM\_CNT\_1

**Subaddress: 01 (R/W)**

| MSB |   |   |   | LSB        |            |           |           |
|-----|---|---|---|------------|------------|-----------|-----------|
| X   | X | X | X | TERM_CNT11 | TERM_CNT10 | TERM_CNT9 | TERM_CNT8 |

TERM\_CNT[11..8]:

See register TERM\_CNT\_0.  
Default: 0x5

Default TERM\_CNT: 0x520 = 1312 pixels/line (XGA@75 Hz)

### 3.2.3 Register Name: NOM\_INC\_0

**Subaddress: 02 (R/W)**

| MSB      |          |          |          |          |          |          | LSB      |
|----------|----------|----------|----------|----------|----------|----------|----------|
| NOM_INC7 | NOM_INC6 | NOM_INC5 | NOM_INC4 | NOM_INC3 | NOM_INC2 | NOM_INC1 | NOM_INC0 |

NOM\_INC[7..0]:

NOM\_INC[32..27]: integer part of DTO increment value  
NOM\_INC[26..0] : fractional part of DTO increment value  
(See Appendix A for how to calculate the increment)  
Default: 0x16

### 3.2.4 Register Name: NOM\_INC\_1

**Subaddress: 03 (R/W)**

| MSB       |           |           |           |           |           |          | LSB      |
|-----------|-----------|-----------|-----------|-----------|-----------|----------|----------|
| NOM_INC15 | NOM_INC14 | NOM_INC13 | NOM_INC12 | NOM_INC11 | NOM_INC10 | NOM_INC9 | NOM_INC8 |

NOM\_INC[15..8]:

See register NOM\_INC\_0.  
Default: 0x8A

### 3.2.5 Register Name: NOM\_INC\_2

Subaddress: 04 (R/W)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| NOM_INC23 | NOM_INC22 | NOM_INC21 | NOM_INC20 | NOM_INC19 | NOM_INC18 | NOM_INC17 | NOM_INC16 |

NOM\_INC[23..16]:

See register NOM\_INC\_0.  
Default: 0x2E

### 3.2.6 Register Name: NOM\_INC\_3

Subaddress: 05 (R/W)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| NOM_INC31 | NOM_INC30 | NOM_INC29 | NOM_INC28 | NOM_INC27 | NOM_INC26 | NOM_INC25 | NOM_INC24 |

NOM\_INC[31..24]:

See register NOM\_INC\_0.  
Default: 0xBA

### 3.2.7 Register Name: NOM\_INC\_4

Subaddress: 06 (R/W)

| MSB |   |   |   |   |   |   | LSB       |
|-----|---|---|---|---|---|---|-----------|
| X   | X | X | X | X | X | X | NOM_INC32 |

NOM\_INC32:

See register NOM\_INC\_0  
Default: 0x00

**NOTE:** The default value for NOM\_INC is 0xBA2E8A16. As shown in Appendix A, this can be calculated to correspond to a DTO output frequency of 78.75 MHz (XGA@75Hz).

**IMPORTANT:** To properly update the increment, it is required to successively program NOM\_INC\_0 to NOM\_INC\_4 and then repeat the programming of the two last bytes NOM\_INC3 and NOM\_INC4 in this order. This properly sets the DTO to the new frequency.

### 3.2.8 Register Name: VCODIV

Subaddress: 07 (R/W)

| MSB |   |   |   |   |         | LSB     |         |
|-----|---|---|---|---|---------|---------|---------|
| X   | X | X | X | X | VCODIV2 | VCODIV1 | VCODIV0 |

VCODIV[2..0]:

Divider in analog PLL loop. Determines the internal master clock frequency as VCODIV x master clock frequency (from XTL1–MCLK/XTL2).

Default: 0x03, corresponds to an analog multiplier of 8, producing an internal nominal frequency of 8x14.31818 MHz

| VCO_DIV[2..0] | ANALOG PLL MULTIPLIER |
|---------------|-----------------------|
| 000           | 5                     |
| 001           | 6                     |
| 010           | 7                     |
| 011 (default) | 8                     |
| 100           | 9                     |
| 101           | 10                    |
| 110           | 11                    |
| 111           | 12                    |

### 3.2.9 Register Name: SELCLK

Subaddress: 08 (R/W)

| MSB |   |   |   |   |   | LSB     |         |
|-----|---|---|---|---|---|---------|---------|
| X   | X | X | X | X | X | SELCLK1 | SELCLK0 |

SELCLK[1..0]:

Selects a clock divider on the DTO output, as shown below:  
Default: 0x01, corresponds to DTO divider = 2

Depending on the desired output clock frequency, SELCLK must be programmed as follows for VCODIV=8:

| SEL_CLK[1..0] | DIVIDER CLKDIV | Output Clock Range (MHz) |
|---------------|----------------|--------------------------|
| 00            | Illegal        | –                        |
| 01 (default)  | 2              | 107 – 57.5               |
| 10            | 4              | 57.5 – 28.5              |
| 11            | 8              | 28.5 – 14.25             |

When an output frequency lower than 14.25 MHz is desired, VCODIV needs to be lowered to 7. For a given VCODIV and desired output frequency, the NOM\_INC setting changes as follows according to the formula in Appendix A.

### 3.2.10 Register Name: PHASESEL

Subaddress: 09 (R/W)

| MSB |   |   |           |           | LSB       |           |           |
|-----|---|---|-----------|-----------|-----------|-----------|-----------|
| X   | X | X | PHASESEL4 | PHASESEL3 | PHASESEL2 | PHASESEL1 | PHASESEL0 |

PHASESEL[4..0]:

Sets the phase for the DTO clock output  
Default: 0x10, corresponding to a phase shift = 180 degrees

### 3.2.11 Register Name: PLLFILT

Subaddress: 0A (R/W)

| MSB |   |         |         |         |         | LSB     |         |
|-----|---|---------|---------|---------|---------|---------|---------|
| X   | X | GAIN_N2 | GAIN_N1 | GAIN_N0 | GAIN_P2 | GAIN_P1 | GAIN_P0 |

GAIN\_N[2..0]: PLL gain control: Sets the loop filter proportional time constant  
Default: 0x7 (highest gain – lowest time constant)

GAIN\_P[2..0]: PLL gain control: Sets the loop filter integrator time constant  
Default: 0x7 (highest gain – lowest time constant)

**NOTE:** The higher the PLL gain setting, the less critical the initial DTO programming becomes since the device will have a wider lock-in range. However, once lock is acquired, any jitter on HS is amplified. Therefore, for high jitter sources, it is recommended to apply more filtering once lock is acquired to filter out this HS jitter.

### 3.2.12 Register Name: HS\_WIDTH

Subaddress: 0B (R/W)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| HS_WIDTH7 | HS_WIDTH6 | HS_WIDTH5 | HS_WIDTH4 | HS_WIDTH3 | HS_WIDTH2 | HS_WIDTH1 | HS_WIDTH0 |

HS\_WIDTH[7..0]:

Sets the width in pixels for HS detection. If the width of the incoming HS is less than this number, it is ignored. The width in pixels of an incoming HS is incremented at each pixel following the active edge (of which the polarity can be programmed, see HS\_POL)

Default: 0x00

### 3.2.13 Register Name: VS\_WIDTH

Subaddress: 0C (R/W)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| VS_WIDTH7 | VS_WIDTH6 | VS_WIDTH5 | VS_WIDTH4 | VS_WIDTH3 | VS_WIDTH2 | VS_WIDTH1 | VS_WIDTH0 |

VS\_WIDTH[7..0]:

Sets the width in lines for VS detection. If the width of the incoming VS is less than this number, it is ignored. The width in lines of an incoming VS is incremented each time a valid HS is detected during a VS active. Therefore, the programmed width is the minimum number of horizontal syncs spanned by the active duration of VS.

Default: 0x00

### 3.2.14 Register Name: SYNC\_CTRL

Subaddress: 0D (R/W)

| MSB |   |   |   |        |       | LSB    |       |
|-----|---|---|---|--------|-------|--------|-------|
| X   | X | X | X | HS_POL | HS_MS | VS_POL | VS_MS |

HS\_POL:

Controls the polarity of the incoming HS  
0 = positive polarity (default)  
1 = negative polarity

HS\_MS:

Controls the mux selection for activating the noise filter on incoming HS  
0 = noise filter disabled (default)  
1 = noise filter enabled

VS\_POL:

Controls the polarity of the incoming VS  
0 = positive polarity (default)  
1 = negative polarity

VS\_MS:

Controls the mux selection for activating the noise filter on incoming VS  
0 = noise filter disabled (default)  
1 = noise filter enabled

### 3.2.15 Register Name: LD\_THRES

Subaddress: 0E (R/W)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| LD_THRES7 | LD_THRES6 | LD_THRES5 | LD_THRES4 | LD_THRES3 | LD_THRES2 | LD_THRES1 | LD_THRES0 |

LD\_THRES[7..0]:

Sets hysteresis for PLL lock-detection output.

An internal counter counts the number of subsequent lines onto which lock is found, as follows: for each line (HS) on which the PFD finds that the PLL is locked, the counter is incremented by 1. The counter clips at 255 maximum. For each line (HS) that the PLL is not locked to, the counter is decremented by 8. This counter starts from 0.

Lock is signaled externally (via the LOCK\_DETECT output) when this internal counter holds a value higher than <LD\_THRESHOLD>. Unlock is signaled externally when this internal counter holds a value less than or equal to <LD\_THRESHOLD>. So, a value of 255 will never assert the lock signal, although the PLL might be locked internally.

**NOTE:** the higher this value is set, the more critical the PFD will be to signal lock. Therefore, this value must be lower for high jitter HS inputs than for high quality sources.

Default: 0x10 = 16

### 3.2.16 Register Name: PLL\_CTRL

Subaddress: 0F (R/W)

| MSB |   |             |            | LSB  |      |      |      |
|-----|---|-------------|------------|------|------|------|------|
| X   | X | DISABLE_PFD | SEL_ADCCLK | INV2 | DIV2 | INV3 | DIV3 |

DISABLE\_PFD:

Disables updating of the DTO increment (i.e., keeps DTO output frequency constant and independent of the incoming HS frequency). This effect is similar as opening the PLL loop.

0 = PFD enabled

1 = PFD disabled (default): the DTO runs at a constant frequency, as determined by NOM\_INC. This means the output frequency returns to the nominal value and further updating of the DTO output frequency is avoided (the PLL loop is open). This is chosen as the default mode to avoid false random frequency changes by the DTO caused by noise on the HS input. In normal operation the microprocessor periodically checks the SYNC\_DETECT register. If sync is present/absent, then the PFD is enabled/disabled so, frequency drift is avoided when no input signal is present. Still the panel can be driven then by data with a nominal pixel frequency.

SEL\_ADCCLK:

Selects the PLL clock or the clock signal on the EXT\_ADCCLK pin, as the clock source for the ADC channels

0: internal clock selected (default)

1: external clock selected

INV2 :

Selects inverting or noninverting clock output on ADCCLK2 output pin

0: the output is not inverted (default) with respect to the internal ADCCLK1 clock

1: the output is inverted with respect to the internal ADCCLK1 clock

DIV2:

Enables divide-by-2 function on the clock output of ADCCLK2

0: divide by 2 mechanism is disabled (default)

1: divide by 2 mechanism is enabled

INV3:

Selects inverting or noninverting output on DTOCLK3, with respect to the internal DTOCLK3 clock

0: the output is not inverted (default)

1: the output is inverted

DIV3:

Enables divide-by-2 function on the clock output of DTOCLK3

0: divided by 2 mechanism is disabled (default)

1: divided by 2 mechanism is enabled

### 3.2.17 Register Name: HS\_COUNT\_0

Subaddress: 10 (R)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| HS_COUNT7 | HS_COUNT6 | HS_COUNT5 | HS_COUNT4 | HS_COUNT3 | HS_COUNT2 | HS_COUNT1 | HS_COUNT0 |

HS\_COUNT[7..0]

HS\_COUNT[11..0] holds the last horizontal sync period number (i.e., the number of pixel clock cycles between the last two HS occurrences). The device updates the value at each active edge of HS. Internal arbitration logic avoids potential read errors between the register contents and the asynchronous I<sup>2</sup>C bus. This value can be read by the microcontroller to derive the line frequency of the incoming video/graphics format.

Default: (changed during operation)

**3.2.18 Register Name: HS\_COUNT\_1****Subaddress: 11 (R)**

| MSB |   |   |   | LSB        |            |           |           |
|-----|---|---|---|------------|------------|-----------|-----------|
| X   | X | X | X | HS_COUNT11 | HS_COUNT10 | HS_COUNT9 | HS_COUNT8 |

HS\_COUNT[11..8]:

See register HS\_COUNT\_0

Default: (changed during operation)

**3.2.19 Register Name: VS\_COUNT\_0****Subaddress: 12 (R)**

| MSB       |           |           |           | LSB       |           |           |           |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| VS_COUNT7 | VS_COUNT6 | VS_COUNT5 | VS_COUNT4 | VS_COUNT3 | VS_COUNT2 | VS_COUNT1 | VS_COUNT0 |

VS\_COUNT[7..0]:

VS\_COUNT[11..0] holds the last vertical sync period number (i.e., the number of line periods between the last two VS occurrences). The device updates the value at each active edge of VS. Internal arbitration logic avoids potential read errors between the register contents and the asynchronous I<sup>2</sup>C bus. This value can be read by the microcontroller to derive the frame rate of the incoming video/graphics format.

Default: (changed during operation)

**3.2.20 Register Name: VS\_COUNT\_1****Subaddress: 13 (R)**

| MSB |   |   |   | LSB        |            |           |           |
|-----|---|---|---|------------|------------|-----------|-----------|
| X   | X | X | X | VS_COUNT11 | VS_COUNT10 | VS_COUNT9 | VS_COUNT8 |

VS\_COUNT[11..8]

See register VS\_COUNT0

Default: (changed during operation)

**3.2.21 Register Name: DTO\_INC\_0****Subaddress: 14 (R)**

| MSB      |          |          |          | LSB      |          |          |          |
|----------|----------|----------|----------|----------|----------|----------|----------|
| DTO_INC7 | DTO_INC6 | DTO_INC5 | DTO_INC4 | DTO_INC3 | DTO_INC2 | DTO_INC1 | DTO_INC0 |

DTO\_INC[7..0]

DTO\_INC[32..0] stores the current value of the DTO increment. This can be read by the microcontroller to derive the actual pixel clock frequency.

Default: (changed during operation)

**3.2.22 Register Name: DTO\_INC\_1****Subaddress: 15 (R)**

| MSB       |           |           |           | LSB       |           |          |          |
|-----------|-----------|-----------|-----------|-----------|-----------|----------|----------|
| DTO_INC15 | DTO_INC14 | DTO_INC13 | DTO_INC12 | DTO_INC11 | DTO_INC10 | DTO_INC9 | DTO_INC8 |

DTO\_INC[15..8]:

See register DTO\_INC\_0

Default: (changed during operation)

**3.2.23 Register Name: DTO\_INC\_2****Subaddress: 16 (R)**

|           |           |           |           |           |           |           |           |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| MSB       |           |           |           | LSB       |           |           |           |
| DTO_INC23 | DTO_INC22 | DTO_INC21 | DTO_INC20 | DTO_INC19 | DTO_INC18 | DTO_INC17 | DTO_INC16 |

DTOINC[23..16]:

See register DTO\_INC\_0  
Default: (changed during operation)

**3.2.24 Register Name: DTO\_INC\_3****Subaddress: 17 (R)**

|           |           |           |           |           |           |           |           |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| MSB       |           |           |           | LSB       |           |           |           |
| DTO_INC31 | DTO_INC30 | DTO_INC29 | DTO_INC28 | DTO_INC27 | DTO_INC26 | DTO_INC25 | DTO_INC24 |

DTO\_INC[31..24]:

See register DTO\_INC\_0.  
Default: (changed during operation)

**3.2.25 Register Name: DTO\_INC\_4****Subaddress: 18 (R)**

|     |   |   |   |     |   |   |           |
|-----|---|---|---|-----|---|---|-----------|
| MSB |   |   |   | LSB |   |   |           |
| X   | X | X | X | X   | X | X | DTO_INC32 |

DTO\_INC32:

See register DTO\_INC\_0.  
Default: (changed during operation)

**3.2.26 Register Name: SYNC\_DETECT****Subaddress: 19 (R)**

|     |   |   |   |     |   |   |         |
|-----|---|---|---|-----|---|---|---------|
| MSB |   |   |   | LSB |   |   |         |
| X   | X | X | X | X   | X | X | NO_SYNC |

NO\_SYNC:

Sync detection on HS.  
0 = HS present  
1 = HS missing  
Default: (changed during operation)

**3.2.27 Register Name: CLP\_CTRL****Subaddress: 20 (R/W)**

|     |        |         |         |         |         |         |         |
|-----|--------|---------|---------|---------|---------|---------|---------|
| MSB |        |         |         | LSB     |         |         |         |
|     | CLPSEL | CLP1_EN | CLP1_RG | CLP2_EN | CLP2_RG | CLP3_EN | CLP3_RG |

CLPSEL Selects the clamp timing signal

0: internal clamp timing pulse is selected (default)  
1: external clamp timing pulse is selected

CLP1\_EN: Enables/disables clamping on channel 1

1: enable (default)  
0: disable

CLP1\_RG: Sets the clamp range for channel 1

1: middle range  
0: bottom range (default)

CLP2\_EN: Enables/disables clamping on channel 2

1: enable (default)

0: disable

CLP2\_RG: Sets the clamp range for channel 2

1: middle range

0: bottom range (default)

CLP3\_EN: Enables/disables clamping on channel 3

1: enable (default)

0: disable

CLP3\_RG: Sets the clamp range for channel 3

1: middle range

0: bottom range (default)

### 3.2.28 Register Name: CLP\_START\_0

Subaddress: 21 (R/W)

| MSB        |            |            |            |            |            |            | LSB        |
|------------|------------|------------|------------|------------|------------|------------|------------|
| CLP_START7 | CLP_START6 | CLP_START5 | CLP_START4 | CLP_START3 | CLP_START2 | CLP_START1 | CLP_START0 |

CLP\_START[7..0]:

CLP\_START[11..0] sets the pixel count value that defines the start of the internal clamping pulse. If external clamping is selected (via CLPSEL) this value has no meaning.

Default: 0x2

### 3.2.29 Register Name: CLP\_START\_1

Subaddress: 22 (R/W)

| MSB |   |   |   | LSB         |             |            |            |
|-----|---|---|---|-------------|-------------|------------|------------|
| X   | X | X | X | CLP_START11 | CLP_START10 | CLP_START9 | CLP_START8 |

CLP\_START[11..8]:

See register CLP\_START\_0

Default: 0x00

### 3.2.30 Register Name: CLP\_STOP\_0

Subaddress: 23 (R/W)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CLP_STOP7 | CLP_STOP6 | CLP_STOP5 | CLP_STOP4 | CLP_STOP3 | CLP_STOP2 | CLP_STOP1 | CLP_STOP0 |

CLP\_STOP[7..0]:

CLP\_STOP[11..0] sets the pixel count value that defines the end of the internal clamping pulse. If external clamping is selected (via CLPSEL) this value has no meaning.

Default: 0x40 = 64

### 3.2.31 Register Name: CLP\_STOP\_1

Subaddress: 24 (R/W)

| MSB |   |   |   | LSB        |            |           |           |
|-----|---|---|---|------------|------------|-----------|-----------|
| X   | X | X | X | CLP_STOP11 | CLP_STOP10 | CLP_STOP9 | CLP_STOP8 |

CLP\_STOP[11..8]:

See register CLP\_STOP\_0

Default: 0x00

**NOTE:** A setting of about 62 clamp clock cycles is sufficient to assure enough clamp timing (>500 ns) at worst case (=highest clock frequency).

**3.2.32 Register Name: CH1\_CLP****Subaddress: 25 (R/W)**

| MSB      |          |          |          |          |          |          | LSB      |
|----------|----------|----------|----------|----------|----------|----------|----------|
| CH1_CLP7 | CH1_CLP6 | CH1_CLP5 | CH1_CLP4 | CH1_CLP3 | CH1_CLP2 | CH1_CLP1 | CH1_CLP0 |

CH1\_CLP[7..0]

Programmable clamp value for channel 1  
 Default: 0x80 = 128 (mid-range)

**3.2.33 Register Name: CH1\_COARSE****Subaddress: 26 (R/W)**

| MSB |   |             |             |             |             |             | LSB         |
|-----|---|-------------|-------------|-------------|-------------|-------------|-------------|
| X   | X | CH1_COARSE5 | CH1_COARSE4 | CH1_COARSE3 | CH1_COARSE2 | CH1_COARSE1 | CH1_COARSE0 |

CH1\_COARSE[5..0]

Coarse PGA value for channel 1  
 Default: 0x20 = 32 (mid-range)

**3.2.34 Register Name: CH1\_FINE****Subaddress: 27 (R/W)**

| MSB |   |   |           |           |           |           | LSB       |
|-----|---|---|-----------|-----------|-----------|-----------|-----------|
| X   | X | X | CH1_FINE4 | CH1_FINE3 | CH1_FINE2 | CH1_FINE1 | CH1_FINE0 |

CH1\_FINE[4..0]

Fine PGA value for channel 1  
 Default: 0x10 = 16 (mid-range)

**3.2.35 Register Name: CH2\_CLP****Subaddress: 28 (R/W)**

| MSB      |          |          |          |          |          |          | LSB      |
|----------|----------|----------|----------|----------|----------|----------|----------|
| CH2_CLP7 | CH2_CLP6 | CH2_CLP5 | CH2_CLP4 | CH2_CLP3 | CH2_CLP2 | CH2_CLP1 | CH2_CLP0 |

CH2\_CLP[7..0]

Programmable clamp value for channel 2  
 Default: 0x80 = 128 (mid-range)

**3.2.36 Register Name: CH2\_COARSE****Subaddress: 29 (R/W)**

| MSB |   |             |             |             |             |             | LSB         |
|-----|---|-------------|-------------|-------------|-------------|-------------|-------------|
| X   | X | CH2_COARSE5 | CH2_COARSE4 | CH2_COARSE3 | CH2_COARSE2 | CH2_COARSE1 | CH2_COARSE0 |

CH2\_COARSE[5..0]

Coarse PGA value for channel 2  
 Default: 0x20 = 32 (mid-range)

**3.2.37 Register Name: CH2\_FINE****Subaddress: 2A (R/W)**

| MSB |   |   |           |           |           |           | LSB       |
|-----|---|---|-----------|-----------|-----------|-----------|-----------|
| X   | X | X | CH2_FINE4 | CH2_FINE3 | CH2_FINE2 | CH2_FINE1 | CH2_FINE0 |

CH2\_FINE[4..0]

Fine PGA value for channel 2  
 Default: 0x10 = 16 (mid-range)

**3.2.38 Register Name: CH3\_CLP****Subaddress: 2B (R/W)**

| MSB      |          |          |          |          |          |          | LSB      |
|----------|----------|----------|----------|----------|----------|----------|----------|
| CH3_CLP7 | CH3_CLP6 | CH3_CLP5 | CH3_CLP4 | CH3_CLP3 | CH3_CLP2 | CH3_CLP1 | CH3_CLP0 |

CH3\_CLP[7..0]

Programmable clamp value for channel 3  
 Default: 0x80 = 128 (mid-range)

**3.2.39 Register Name: CH3\_COARSE****Subaddress: 2C (R/W)**

| MSB |   |             |             |             |             |             | LSB         |
|-----|---|-------------|-------------|-------------|-------------|-------------|-------------|
| X   | X | CH3_COARSE5 | CH3_COARSE4 | CH3_COARSE3 | CH3_COARSE2 | CH3_COARSE1 | CH3_COARSE0 |

CH3\_COARSE[5..0]

Coarse PGA value for channel 3  
 Default: 0x20 = 32 (mid-range)

**3.2.40 Register Name: CH3\_FINE****Subaddress: 2D (R/W)**

| MSB |   |   |           |           |           |           | LSB       |
|-----|---|---|-----------|-----------|-----------|-----------|-----------|
| X   | X | X | CH3_FINE4 | CH3_FINE3 | CH3_FINE2 | CH3_FINE1 | CH3_FINE0 |

CH3\_FINE[4..0]

Fine PGA value for channel 3  
 Default: 0x10 = 16 (mid-range)

**3.2.41 Register Name: PIX\_TRAP\_0****Subaddress: 2E (R/W)**

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| PIX_TRAP7 | PIX_TRAP6 | PIX_TRAP5 | PIX_TRAP4 | PIX_TRAP3 | PIX_TRAP2 | PIX_TRAP1 | PIX_TRAP0 |

PIX\_TRAP[7..0]

PIX\_TRAP[10..0] sets the pixel count value in a line to be sampled. Each <PIX\_TRAP>th value on each line is stored in the CH<n>\_RDBK registers

Default: 0x04

**3.2.42 Register Name: PIX\_TRAP\_1****Subaddress: 2F (R/W)**

| MSB |   |   |   |            |            |           | LSB       |
|-----|---|---|---|------------|------------|-----------|-----------|
| X   | X | X | X | PIX_TRAP11 | PIX_TRAP10 | PIX_TRAP9 | PIX_TRAP8 |

PIX\_TRAP[11..8]:

See register PIX\_TRAP\_0  
 Default: 0x00

**3.2.43 Register Name: PWDN\_CTRL****Subaddress: 30 (R/W)**

| MSB |   |   |          |   |          |           | LSB     |
|-----|---|---|----------|---|----------|-----------|---------|
| X   | X | X | PWDN_ALL | X | PWDN_REF | PWDN_BGAP | DTO_DIS |

PWDN\_ALL

Powers down complete chip excluding I<sup>2</sup>C, clamping, and composite sync slicer. Enables *green* mode for monitor standby.

0 = active (default)  
 1 = powered down

#### PWDN\_REF

Powers down internal top and bottom references for all channels (VREFT / VREFB). If powered down, enables user to supply external VREFT / VREFB references on corresponding pins.

0 = active (default)  
1 = powered down

#### PWDN\_BGAP

Powers down bandgap reference. If powered down, enables user to supply external VMID (input common mode voltage) on corresponding pin.

0 = active (default)  
1 = powered down

#### DTO\_DIS

Disables the DTO. Can be disabled when an external clock (EXT\_ADCCLK) is used and the user does not intend to use the PLL output on DTOCLK3. When the PLL is active, it can be used as the clock source for the ADC channels or the ADC's can still run from EXT\_ADCCLK depending on the SEL\_ADCCLK register setting. Note that when the DTO is enabled and the device is configured to use an external clock, the DTO clock is still available on the DTOCLK3 pin so it can be used as a general-purpose clock synthesizer for other parts in the system, possibly the display clock if this is different from the input pixel clock.

Since the DTO is also used for internal clock generation, power should always be supplied to the PLL supply pins, even when the ADC sampling clock is fed from EXT\_ADCCLK and DTO\_DIS is active.

0 = active (default)  
1 = powered down

### 3.2.44 Register Name: AUX\_CTRL

Subaddress: 31 (R/W)

| MSB |   |        |        | LSB   |       |       |      |
|-----|---|--------|--------|-------|-------|-------|------|
| X   | X | CS_SEL | CS_DIS | TEST2 | TEST1 | TEST0 | TACT |

#### CS\_SEL

Composite sync select. Selects the source of the composite sync for slicing.

0 = from Ch1 input  
1 = from CS\_IN input

#### CS\_DIS

Enables/disables the composite sync output on terminal CS/TEST1. The state of the CS output is also dependent on the clamp range (see *Composite Sync Slicer* section).

0 = enabled (default)  
1 = disabled

#### TEST[2..0]

#### TACT

Used for TI factory testing only; should not be changed from its all-0 default value.

### 3.2.45 Register Name: CH1\_RDBK

Subaddress: 32 (R)

| MSB       |           |           |           | LSB       |           |           |           |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CH1_RDBK7 | CH1_RDBK6 | CH1_RDBK5 | CH1_RDBK4 | CH1_RDBK3 | CH1_RDBK2 | CH1_RDBK1 | CH1_RDBK0 |

#### CH1\_RDBK[7..0]:

Readback register of ADC channel 1  
Default: (changed during operation)

### 3.2.46 Register Name: CH2\_RDBK

Subaddress: 33 (R)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CH2_RDBK7 | CH2_RDBK6 | CH2_RDBK5 | CH2_RDBK4 | CH2_RDBK3 | CH2_RDBK2 | CH2_RDBK1 | CH2_RDBK0 |

CH2\_RDBK[7..0]:

Readback register of ADC channel 2

Default: (changed during operation)

### 3.2.47 Register Name: CH3\_RDBK

Subaddress: 34 (R)

| MSB       |           |           |           |           |           |           | LSB       |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| CH3_RDBK7 | CH3_RDBK6 | CH3_RDBK5 | CH3_RDBK4 | CH3_RDBK3 | CH3_RDBK2 | CH3_RDBK1 | CH3_RDBK0 |

CH3\_RDBK[7..0]:

Readback register of ADC channel 3

Default: (changed during operation)

### 3.2.48 Register Name: OFM\_CTRL

Subaddress: 40 (R/W)

| MSB |   |   |   |          |         |           | LSB       |
|-----|---|---|---|----------|---------|-----------|-----------|
| X   | X | X | X | DHS_MODE | DHS_POL | OFM_MODE1 | OFM_MODE0 |

DHS\_MODE

Controls how DHS (display horizontal sync output) is generated. DHS can be a version of the signal on the HS input terminal, synchronized to the sampling clock and compensated for the data pipeline delay through the part (see timing diagrams). This preserves the HS width but has the disadvantage that, for some phase settings, there is a one-pixel uncertainty on the exact timing of DHS (if HS falls within setup/hold time of the input register that is clocked by the ADC sampling clock).

Therefore, a second option exist to generate DHS as the output pulse of the PLL feedback divider. Since this pulse is generated once for every <TERM\_CNT> cycles of the DTO clock, the uncertainty is resolved. This can avoid possible horizontal line jitter on the display system. The width of the DHS pulse is in this case always 1 ADC clock cycle, independent of the width of the incoming HS. This method also assures the generation of a DHS pulse on every line, even when no incoming HS is present or when it is filtered out by sync processing (e.g., from composite sync extraction).

0 = DHS is generated from the output of the PLL feedback divider (default)

1 = DHS is generated as a latched and delayed version of HS input

DHS\_POL

Controls polarity of the DHS output

0 = positive polarity (default)

1 = negative polarity

OFM\_MODE[1..0]:

Defines mode of output formatter and frequency on DATACLK1 as in Table 3–2.

**Table 3–2. Output Formatter**

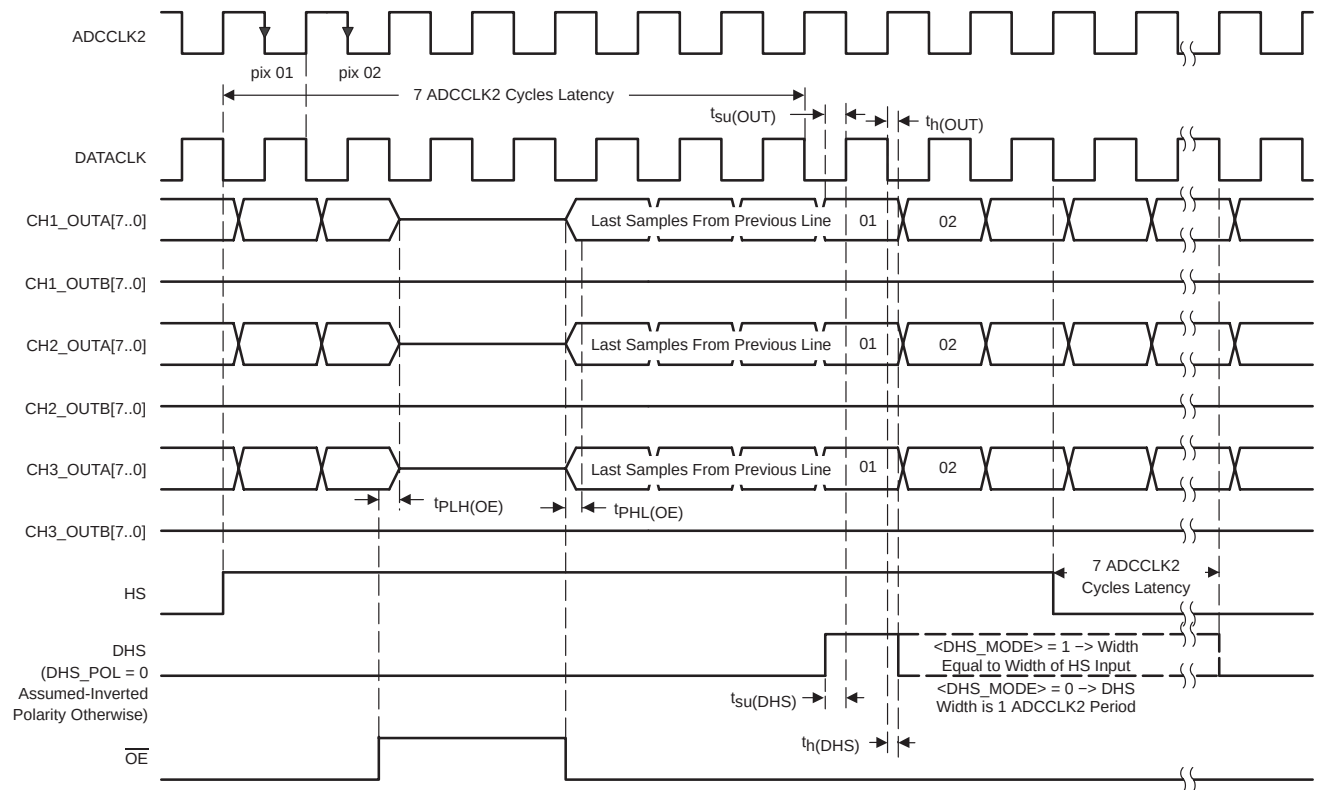
| OFM_MODE<br>[1..0] | DESCRIPTION                                                                                                                                     | DATACLK1 OUT-<br>PUT FREQUENCY |
|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|
| 00 (default)       | 24-bit parallel mode:<br>24-bit output on bus A, bus B is Hi-Z                                                                                  | Fs                             |
| 01                 | 16-bit mode<br>16-bit output on ch1 and ch2 of bus A, with data from ch2 and ch3 downsampled by 2 (parallel 4:2:2 CCIR–601 mode), bus B is Hi-Z | Fs                             |
| 10                 | 48-bit interleaved mode<br>48-bit output on buses A and B at half sampling rate. Data on bus B shifted by 1 Fs clock.                           | Fs/2                           |
| 11                 | 48-bit parallel mode<br>48-bit output on buses A and B at half sampling rate                                                                    | Fs/2                           |

## 4 Parameter Measurement Information

All timing diagrams are shown for operation with internal PLL clock at phase 0, and ADCCLK2 non-inverted and non-divided-by-2.

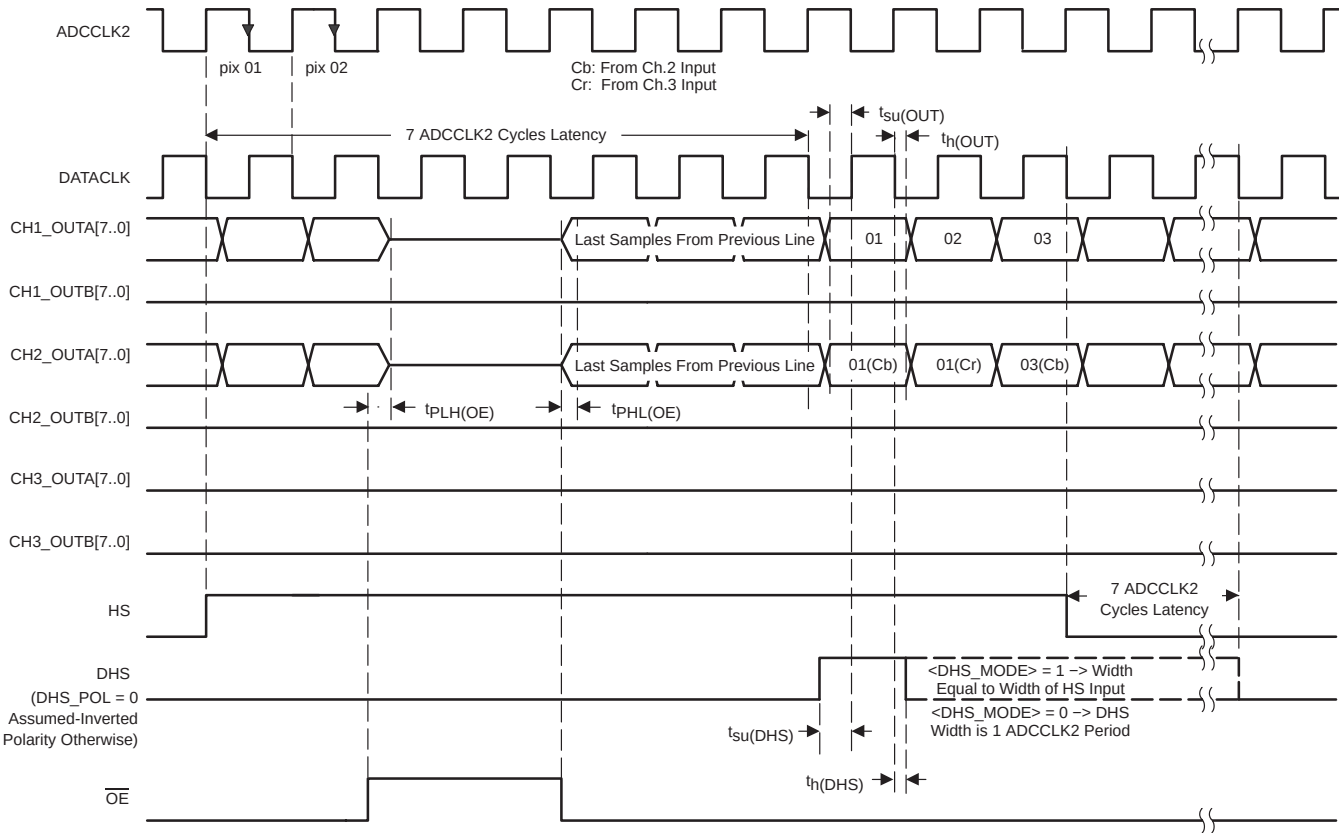
### 4.1 Timing Diagram—24-Bit Parallel Mode

This mode outputs data on the three channels simultaneously in single-pixel mode. DATACLK1 is at the sampling clock frequency; output bus B remains high-impedance.



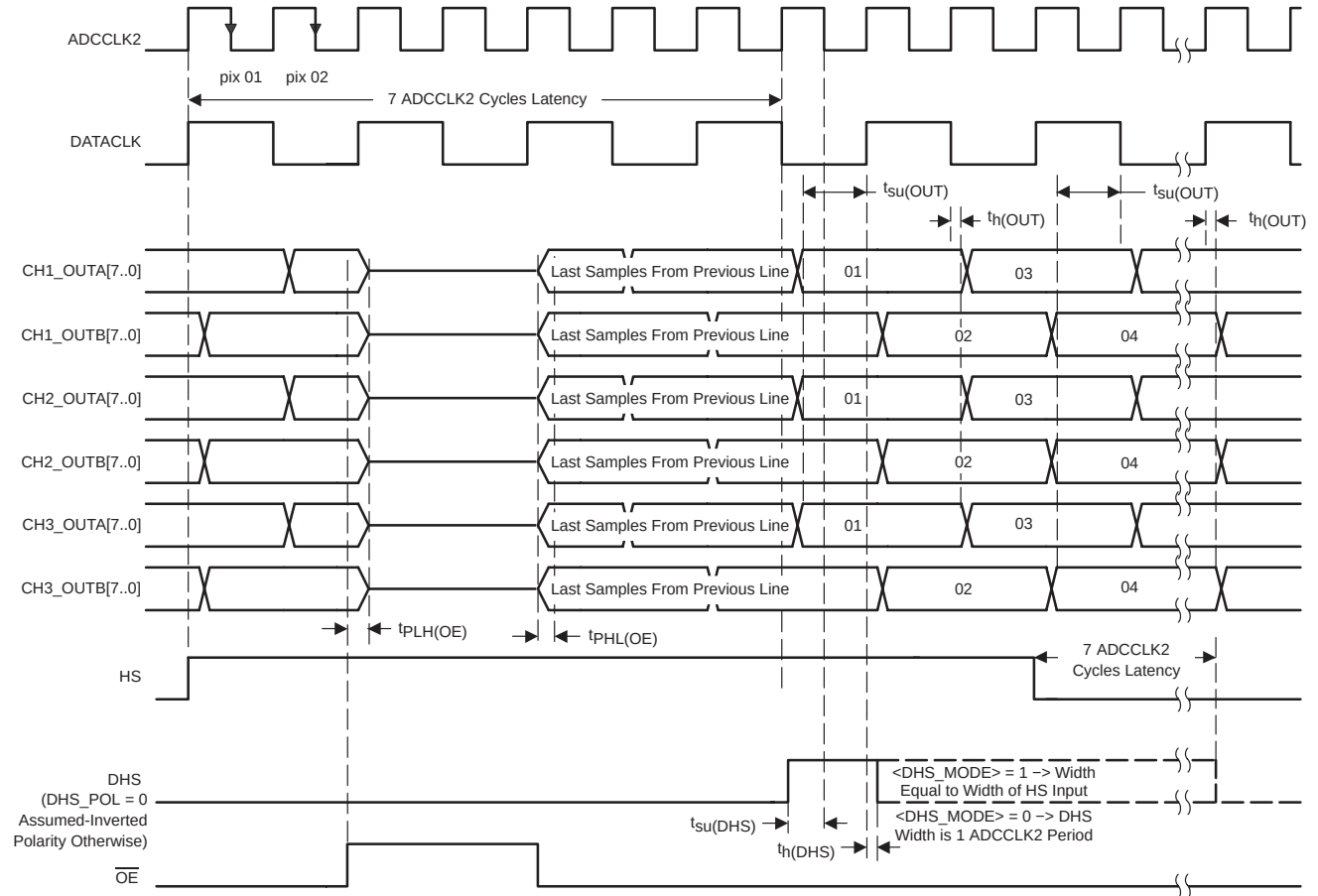
## 4.2 Timing Diagram—16-Bit Parallel Mode

This is the ITU-R.BT-601 style mode typically used in YUV operation of the part with a Y analog input connected to the Ch1 input of the THS8083A, and with Cb and Cr connected to the Ch2 and Ch3 inputs, respectively. The DATACLK1 output is at the sampling clock frequency and Ch3 remains unused. The output bus B of all channels is high impedance. The HS\_D signal can be used to uniquely identify output data Cb from Cr.



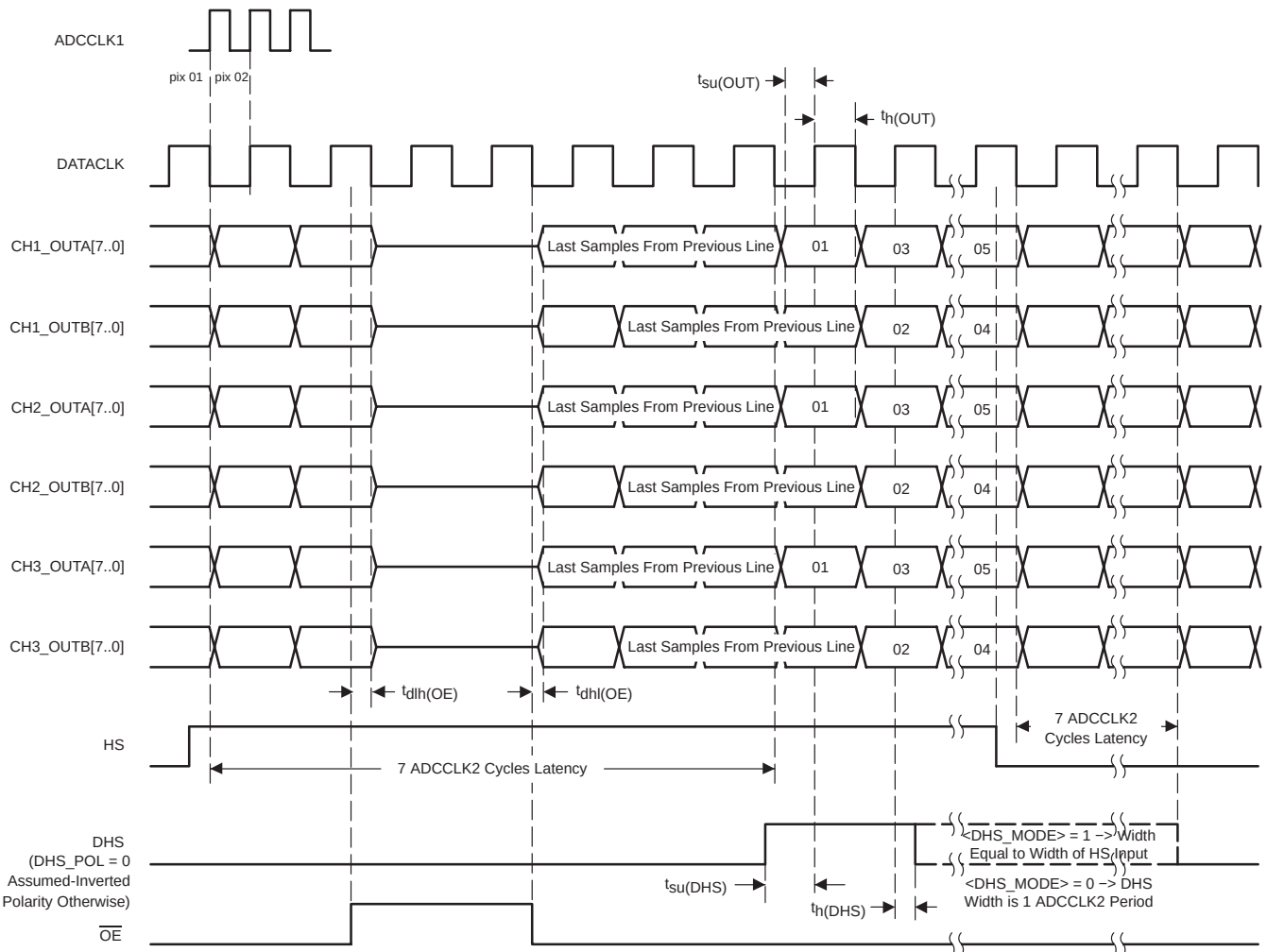
### 4.3 Timing Diagram—48-Bit Interleaved Mode

This mode allows a double-pixel width output interface with one sampling clock period time offset between buses A and B. The DATACLK1 output is at half of the sampling clock frequency. Data on output bus A precedes data on output bus B.



### 4.4 Timing Diagram—48-Bit Parallel Mode

This mode allows a double-pixel width output interface with no time offset between buses A and B. The DATACLK1 output is at half of the sampling clock frequency. Data on output bus A precedes data on output bus B.



## 5 Electrical Specifications

Electrical specifications over recommended operating conditions with  $F_s = 80$  MSPS (unless otherwise noted)

### 5.1 Definition of Test Conditions



Figure 5-1. Input Test Waveform

Test condition SYSTEM\_INTREF refers to:

- All supplies at 3.3 V
- XTL1\_MCLK & XTL2 connected at 14.31818 MHz
- No power downs enabled
- XGA at 75-Hz operation mode, internal clock, clamping enabled, internal clamp timing, coarse and fine PGAs at midscale, bottom-level clamping, clamp code at midscale, 24-bit output mode
- Identical ac-coupled 0.8 Vpp ramp-shape input on all 3 channels at 60.0-kHz line rate, as shown in Figure 5-1
- Use of internal bandgap and voltage references

Test condition PLL refers to:

- SYSTEM\_INTREF, with an input signal other than the ramp-shape input test waveform of Figure 5-1.

Test condition ADC\_INTREF refers to:

- All supplies at 3.3 V
- Use of internal bandgap and voltage references
- Use of external ADCCLK clock ( $\text{SEL\_ADCCLK} = 1$ ), driven at 81.92 MHz
- No power downs enabled
- Identical ac-coupled, 0.8 Vpp ramp-shape input on all three channels at 60.0-kHz line rate, as shown in Figure 5-1

Test condition ADC\_EXTREF refers to:

- ADC\_INTREF, except:  $\text{PWDN\_BGAP} = \text{PWDN\_REF} = 1$ , VMID and VREFTO/BO driven from an external source at nominal levels

Test condition ADC\_PWDN refers to:

- ADC\_INTREF, except:  $\text{PWDN\_ALL} = 1$

## 5.2 Absolute Maximum Ratings Over Operating Free-Air Temperature Range (unless otherwise noted)

|                                                                                           |                                                   |                           |
|-------------------------------------------------------------------------------------------|---------------------------------------------------|---------------------------|
| Supply voltage range:                                                                     | Analog supplies (see Note 1) to AGND,             |                           |
|                                                                                           | Digital supplies (see Note 2) to DGND             | –0.5 to 4.5 V             |
|                                                                                           | Analog supplies to digital supplies, AGND to DGND | –0.5 to 0.5 V             |
| Digital input voltage range to DGND, $V_I$                                                |                                                   | –0.5 to $DV_{DD} + 0.5$ V |
| Analog input voltage range to AGND, $V_I$                                                 |                                                   | –0.5 to $AV_{DD} + 0.5$ V |
| Bandgap reference to AGND (see Note 3)                                                    |                                                   | –0.5 to $AV_{DD} + 0.5$ V |
| Reference voltage (VREFTO_CHx, VREFBO_CHx) input range to AGND, $V_{ref}$<br>(see Note 4) |                                                   | –0.5 to $AV_{DD} + 0.5$ V |
| Operating free-air temperature range, $T_A$ : THS8083APZP                                 |                                                   | 0°C to 70°C               |
| Storage temperature range, $T_{stg}$                                                      |                                                   | –55°C to 150°C            |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. AVDD\_PLL, AVDD\_REF, AVDD\_CH1, AVDD\_CH2\_3
  2. DVDD\_PLL, DVDD
  3. Only input in case PWDN\_BGAP=1
  4. Only input in case PWDN\_REF=1

## 5.3 Recommended Operating Conditions Over Operating Free-Air Temperature Range, $T_A = 0^\circ\text{C}$ to $70^\circ\text{C}$ (unless otherwise noted)

### 5.3.1 Power Supply

| PARAMETER                    | MIN | NOM | MAX | UNIT |
|------------------------------|-----|-----|-----|------|
| Supply voltage, all supplies | 3.0 | 3.3 | 3.6 | V    |

### 5.3.2 Analog and Reference Inputs (see Note 5)

| PARAMETER                                       | MIN           | NOM  | MAX           | UNIT |
|-------------------------------------------------|---------------|------|---------------|------|
| Reference input voltage (top), $V_{I(REFT)}$    | 1.88          | 1.9  | 1.92          | V    |
| Reference input voltage (bottom), $V_{I(REFB)}$ | 1.08          | 1.10 | 1.12          | V    |
| Analog input voltage (dc-coupled), $V_{I(AIN)}$ | $V_{I(REFB)}$ |      | $V_{I(REFT)}$ | V    |
| Analog input voltage range, $V_I$               |               |      | 1.2           | V    |

NOTE 5: VREFTO\_CHx and VREFBO\_CHx can be inputs only when PWDN\_REF=1.

### 5.3.3 Digital Inputs

| PARAMETER                                 | MIN  | NOM | MAX        | UNIT |
|-------------------------------------------|------|-----|------------|------|
| High-level input voltage, $V_{IH}$        | 2.0  |     | DVDD       | V    |
| Low-level input voltage, $V_{IL}$         | DGND |     | 0.2 x DVDD | V    |
| Clock period, $t_c$                       | 12.5 |     |            | ns   |
| Pulse duration, clock high, $t_{w(CLKH)}$ | 5.25 |     |            | ns   |
| Pulse duration, clock low, $t_{w(CLKL)}$  | 5.25 |     |            | ns   |

## 5.4 Electrical Characteristics Over Recommended Operating Free-Air Temperature Range, $T_A = 0^{\circ}\text{C}$ to $70^{\circ}\text{C}$ (unless otherwise noted)

**NOTE:** In order to reach stated performance levels, the device's PowerPad feature should be thermally and electrically connected to the pcb ground plane, as described in Section 6.1 *Designing With PowerPad*.

### 5.4.1 Power Supply (3.3 V All Supplies)

| PARAMETER                                              | TEST CONDITIONS | MIN | TYP  | MAX  | UNIT |
|--------------------------------------------------------|-----------------|-----|------|------|------|
| Analog supply (=AVDD_CH1+AVDD_CH2_3+AVDD_PLL+AVDD_REF) | ADC_INTREF      |     | 325  | 385  | mA   |
| Digital supply (=DVDD+DVDD_PLL)                        | ADC_INTREF      |     | 119  | 140  | mA   |
| Total power dissipation normal operation               | ADC_INTREF      |     | 1.47 | 1.73 | W    |
| Total power dissipation, power down all modes          | ADC_PWDN        |     |      | 385  | mW   |

### 5.4.2 Digital Logic Inputs (HS, VS, SCL, SDA, I2CA, XTL1\_MCLK, EXT\_ADCCLK, $\overline{\text{OE}}$ , $\overline{\text{RESET}}$ , EXT\_CLP)

| PARAMETER                                                       | TEST CONDITIONS                                                                                               | MIN | TYP | MAX | UNIT          |
|-----------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $I_{IH}$ High-level input current                               | DVDD = 3.6 V,<br>Digital inputs and CLK at 0 V for $I_{IL}$ ;<br>Digital inputs and CLK at 3.6 V for $I_{IH}$ | -10 |     | 10  | $\mu\text{A}$ |
| $I_{IL}$ Low-level input current                                |                                                                                                               | -10 |     | 10  | $\mu\text{A}$ |
| $I_{IL}(\text{CLK})$ Low-level input current, CLK (see Note 6)  |                                                                                                               | -14 |     | 17  | $\mu\text{A}$ |
| $I_{IH}(\text{CLK})$ High-level input current, CLK (see Note 6) |                                                                                                               | -14 |     | 17  | $\mu\text{A}$ |
| $C_I$ Input capacitance                                         |                                                                                                               |     | 5   |     | pF            |

NOTE 6: Applies when XTL1\_MCLK is driven by the clock signal directly.

### 5.4.3 Logic Outputs (SDA, CHn\_OUTA[7..0], CHn\_OUTB[7..0], DTOCLK3, ADCCLK2, DATACLK1, DHS, LOCK)

| PARAMETER                                                           | TEST CONDITIONS                                                              | MIN | TYP | MAX  | UNIT          |
|---------------------------------------------------------------------|------------------------------------------------------------------------------|-----|-----|------|---------------|
| $V_{OH}$ High-level output voltage                                  | DVDD = 3 V at $I_{OH} = 50 \mu\text{A}$ ,<br>Digital output forced high      | 2.9 |     |      | V             |
| $V_{OL}$ Low-level output voltage                                   | DVDD = 3.6 V at $I_{OL} = 50 \mu\text{A}$ ,<br>Digital output forced low     |     |     | 0.15 | V             |
| $C_O$ Output capacitance                                            |                                                                              |     | 5   |      | pF            |
| $I_{OZ(H)}/I_{OZ(L)}^{\dagger}$ High-impedance-state output current | DVDD = 3.6 V<br>Worst case for $V_O = 3.6 \text{ V}$ and $V_O = 0 \text{ V}$ | -10 |     | 10   | $\mu\text{A}$ |

$^{\dagger}$  Tested for CHn-A[7..0] and CHn\_B[7..0] only

## 5.4.4 I<sup>2</sup>C Interface

| PARAMETER              | TEST CONDITIONS                                | MIN                                                                                         | TYP                                | MAX  | UNIT |
|------------------------|------------------------------------------------|---------------------------------------------------------------------------------------------|------------------------------------|------|------|
| V <sub>IL</sub>        | Low-level input voltage                        |                                                                                             |                                    | 0.99 | V    |
| V <sub>IH</sub>        | High-level input voltage                       | 2.31                                                                                        |                                    |      | V    |
| f(SCL)                 | SCL clock frequency                            | 0                                                                                           | 400 <sup>†</sup> /100 <sup>‡</sup> |      | kHz  |
| t <sub>(LOW)</sub>     | Low period of SCL                              | Valid for I <sup>2</sup> C fast mode support only.<br>See footnotes to SCL clock frequency. | 1.3                                |      | μs   |
| t <sub>(HIGH)</sub>    | High period of SCL                             |                                                                                             | 0.6                                |      | μs   |
| t <sub>h</sub> (DATA)  | Data hold time                                 |                                                                                             | 0 <sup>§</sup>                     |      | μs   |
| t <sub>su</sub> (DATA) | Data setup time                                |                                                                                             | 100 <sup>¶</sup>                   |      | μs   |
| C <sub>b</sub>         | Capacitive load for each bus line <sup>#</sup> |                                                                                             |                                    | 400  | pF   |

<sup>†</sup> For DTO clock frequencies 25 MHz minimum (I<sup>2</sup>C fast mode)

<sup>‡</sup> For DTO clock frequencies below 25 MHz (I<sup>2</sup>C normal mode)

<sup>§</sup> The device must internally provide a hold time of 300 ns for the SDA signal (referred to V<sub>IH(min)</sub> of the SCL signal) in order to bridge the undefined region of the falling edge of SCL.

<sup>¶</sup> If the device is used in a standard mode I<sup>2</sup>C system, the requirement of t<sub>su</sub>(DATA) ≥ 250 ns must be met.

<sup>#</sup> C<sub>b</sub> = total capacitance of one bus line in pF

## 5.4.5 ADC Channel

### 5.4.5.1 DC Accuracy<sup>†</sup>

| PARAMETER                       | TEST CONDITIONS          | MIN | TYP | MAX     | UNIT |
|---------------------------------|--------------------------|-----|-----|---------|------|
| Integral nonlinearity (INL)     | PLL (see Note 7)         | -2  | ±1  | 2       | LSB  |
| Differential nonlinearity (DNL) | PLL (see Note 8)         | -1  |     | 1.5     | LSB  |
| No missing codes                |                          |     |     | Assured |      |
| Gain error                      | ADC_INTREF (see Note 9)  |     | 60  |         | mV   |
| Offset error                    | ADC_INTREF (see Note 10) |     | 60  |         | mV   |

<sup>†</sup> Assured at nominal voltage supply levels only.

- NOTES:
7. Integral nonlinearity (INL) —Integral nonlinearity refers to the deviation of each individual code from a line drawn from zero to full scale. The point used as zero occurs 1/2 LSB before the first code transition. The full-scale point is defined as a level 1/2 LSB beyond the last code transition. The deviation is measured from the center of each particular code to the true straight line between these two end points.
  8. Differential nonlinearity (DNL)—An ideal ADC exhibits code transitions that are exactly 1 LSB apart. DNL is the deviation from this ideal value. Therefore, this measure indicates how uniform the transfer function step sizes are. The ideal step size is defined here as the step size for the device under test (i.e., last transition level – first transition level)/(2<sup>n</sup> – 2). Using this definition for DNL separates the effects of gain and offset error. A DNL of less than ±1 LSB ensures no missing codes. A DNL of less than ±1/2 LSB assures monotonic behavior.
  9. Gain error—The first code transition should occur for an analog value 1/2 LSB above nominal negative full scale (the voltage applied to the REFBI terminal). The last transition should occur for an analog value 1/2 LSB below nominal positive full scale (the voltage applied to the REFTI terminal). Gain error is defined here as the deviation from the ideal location of the highest transition level on the ADC transfer function.
  10. Offset error—The first code transition should occur at a level 1/2 LSB above zero. Offset is defined as the deviation of the actual first code transition from that point.

### 5.4.5.2 Dynamic Performance<sup>†</sup>

| PARAMETER                                     | TEST CONDITIONS<br>ADC_INTREF | MIN | TYP | MAX | UNIT |
|-----------------------------------------------|-------------------------------|-----|-----|-----|------|
| Effective number of bits, ENOB (from SNR)     | $f_I = 20 \text{ MHz}$        |     | 6.7 |     | Bits |
| Signal-to-total ratio without distortion, SNR | $f_I = 20 \text{ MHz}$        |     | 42  |     | dB   |
| Total harmonic distortion, THD                | $f_I = 1 \text{ MHz}$         |     | −49 |     | dB   |
| Spurious free dynamic range, SFDR             | $f_I = 1 \text{ MHz}$         |     | 52  |     | dB   |
| Analog input full-power bandwidth, BW         | (see Note 11)                 |     | 500 |     | MHz  |

<sup>†</sup> Based on analog input voltage of 1 dB FS referenced to the full-scale input range and a clock signal with 50% duty cycle

NOTE 11: Analog input bandwidth—The analog input bandwidth is defined as the maximum frequency of the input sine that can be applied to the device for which a 3 dB attenuation is observed in the reconstructed signal.

### 5.4.5.3 Clamp

| PARAMETER                                       | TEST CONDITIONS<br>ADC_INTREF              |                             | MIN | TYP | MAX  | UNIT |
|-------------------------------------------------|--------------------------------------------|-----------------------------|-----|-----|------|------|
| Clamp code adjustment range                     | See Note 12                                |                             | 100 |     | 138  | LSB  |
| Clamp acquisition time at input dc level change | Input level changed by 100 mV              | Within 10% of final value   |     | 1   |      | ms   |
|                                                 |                                            | Within 1 LSB of final value |     | 2.4 |      | ms   |
| Clamp acquisition time, clamp code change       | Clamp changed from minimum to maximum      | Within 1 LSB                |     | 500 | 1000 | ns   |
| Clamp droop error                               | Droop between 2 clamps at 15 kHz line rate |                             |     | 0.5 | 1.6  | LSB  |

NOTE 12: Clamp code adjustment range—A dc-input signal is applied to the device. The clamp code is changed from minimum to maximum setting. The corresponding change in the ADC output code is defined as the clamp code adjustment range.

### 5.4.6 Coarse PGA

| PARAMETER                   | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------------|-----------------|-----|-----|-----|------|
| Full-scale adjustment range |                 | 0.4 |     | 1.2 | V    |
| Accuracy                    |                 | ± 6 |     |     | LSB  |

### 5.4.7 Fine PGA

| PARAMETER                   | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------------------------|-----------------|-----|-----|-----|------|
| Full-scale adjustment range |                 | −4  |     | 8   | LSB  |

## 5.4.8 Output Formatter/Timing Requirements

| PARAMETER                                     |                                                    | TEST CONDITIONS                                     | MIN                 | TYP | MAX | UNIT |
|-----------------------------------------------|----------------------------------------------------|-----------------------------------------------------|---------------------|-----|-----|------|
| f <sub>clk</sub>                              | Maximum conversion rate                            | THS8083A                                            | 80                  |     |     | MHz  |
| f <sub>clk</sub>                              | Minimum conversion rate                            |                                                     |                     |     | 13  | MHz  |
| t <sub>su</sub> (OUT)                         | Setup time                                         | With respect to 50% level of rising edge on DATACLK | 1.6                 |     |     | ns   |
| t <sub>h</sub> (OUT),<br>t <sub>h</sub> (DHS) | Hold time                                          |                                                     | 1                   |     |     | ns   |
| t <sub>su</sub> (DHS)                         | Setup time                                         |                                                     | 2                   |     |     | ns   |
| t <sub>PLH</sub> (OE)                         | Propagation (delay) time, low-to-high              | See Note 13                                         |                     |     | 9.5 | ns   |
| t <sub>PHL</sub> (OE)                         | Propagation (delay) time, high-to-low-level output |                                                     |                     |     | 8.5 |      |
| DATACLK1 output duty cycle                    |                                                    |                                                     | 40%                 |     | 60% |      |
| HS and data pipeline delay                    |                                                    | See Note 14                                         | See timing diagrams |     |     |      |

NOTES: 13. Output timing—OE timing t<sub>PLH</sub>(OE) is measured from the V<sub>IH</sub>(MIN) level of OE to the high-impedance state of the output data. The digital output load is not higher than 10 pF.

OE timing t<sub>PHL</sub>(OE) is measured from the V<sub>IL</sub>(MAX) level of OE to the instant when the output data reaches V<sub>OH</sub>(min) or V<sub>OL</sub>(max) output levels. The digital output load is not higher than 10 pF.

14. Pipeline delay (latency)—The number of clock cycles between conversion initiation on an input sample and the corresponding output data being made available. Once the data pipeline is full, new valid output data are provided every clock cycle.

## 5.4.9 PLL

### 5.4.9.1 Open Loop

| PARAMETER                                |          | TEST CONDITIONS | MIN                    | TYP                     | MAX | UNIT |
|------------------------------------------|----------|-----------------|------------------------|-------------------------|-----|------|
| DTO frequency range, f <sub>(DTO)</sub>  | THS8083A | See Note 15     | 13                     |                         | 80  | MHz  |
| Instantaneous jitter, t <sub>(INS)</sub> |          | See Note 15     |                        | 260                     |     | ps   |
| Short-term jitter, t <sub>(JOS)</sub>    |          |                 | 800 (p-p)<br>240 (rms) | 1250 (p-p)<br>485 (rms) |     | ps   |
| Phase Increment                          |          |                 | 11.25<br>Monotonic     |                         |     | deg  |

NOTE 15: PLL characterization:

- Instantaneous jitter is the pk-pk position variation of the clock rising edge between succeeding periods.
- Short term jitter in open loop or closed loop is defined as the variation of the clock rising edge within one PLL update period (within the same video line). This can be visually measured by capturing the clock and displaying it on a digital scope with a persistency of one video line. Numerically, the time instants of the rising edges, at a defined voltage level, of a number N of clock cycles (N = 800) are captured at a high sampling rate. The average clock time period is calculated from these time instants. The deviation between each actual time instant and the ideal, based on the average clock time period, is defined as a statistically distributed jitter value along one line. This jitter is measured on both DATACLK1 and DTOCLK3 outputs.

### 5.4.9.2 Closed Loop

| PARAMETER                     | TEST CONDITIONS | MIN                     | TYP                     | MAX | UNIT |
|-------------------------------|-----------------|-------------------------|-------------------------|-----|------|
| $f_{(HS)}$ HS locking range   | See Note 16     | 15                      |                         | 100 | kHz  |
| $t_{(acq)}$ Lock-in time      |                 |                         | 5                       |     | ms   |
| $t_{(JCS)}$ Short-term jitter |                 | 925 (p-p)<br>245 (rms)  | 1400 (p-p)<br>450 (rms) |     | ps   |
| $t_{(JCL)}$ Long-term jitter  | See Note 16     | 1000 (p-p)<br>250 (rms) | 1500 (p-p)<br>485 (rms) |     | ps   |

NOTE 16: PLL characterization:

- Short term jitter in open loop or closed loop is defined as the variation within one PLL update period (within the same video line) of the clock rising edge. This is measured visually by capturing the clock and displaying it on a digital scope with a persistency of one video line. Numerically, the time instants of the rising edges, at a defined voltage level, of a number of clock cycles ( $N = 800$ ) are captured at a high sampling rate. The average clock time period is calculated from these time instants. The deviation between each actual time instant and the ideal, based on the average clock time period, is defined as a statistically distributed jitter value along one line. This jitter is measured on both DATACLK1 and DTOCLK3 outputs.
- Long term jitter in closed loop is defined as the variation over one video frame of the Nth clock rising edge on each line. This is measured by capturing the time instant at a defined level on the rising edge of the Nth clock after HS is reached on each line. The calculation uses the same principle used with short term jitter, but now takes one sample on every line and  $N = 800$  lines.

### 5.4.10 Typical Plots (25°C and Measured for Standard VESA Graphics Formats)

**NOTE:** The THS8083 is configured for each video mode with I<sup>2</sup>C register settings as specified in application note *Using THS8083 for PC Graphics and Component Video Digitizing*.

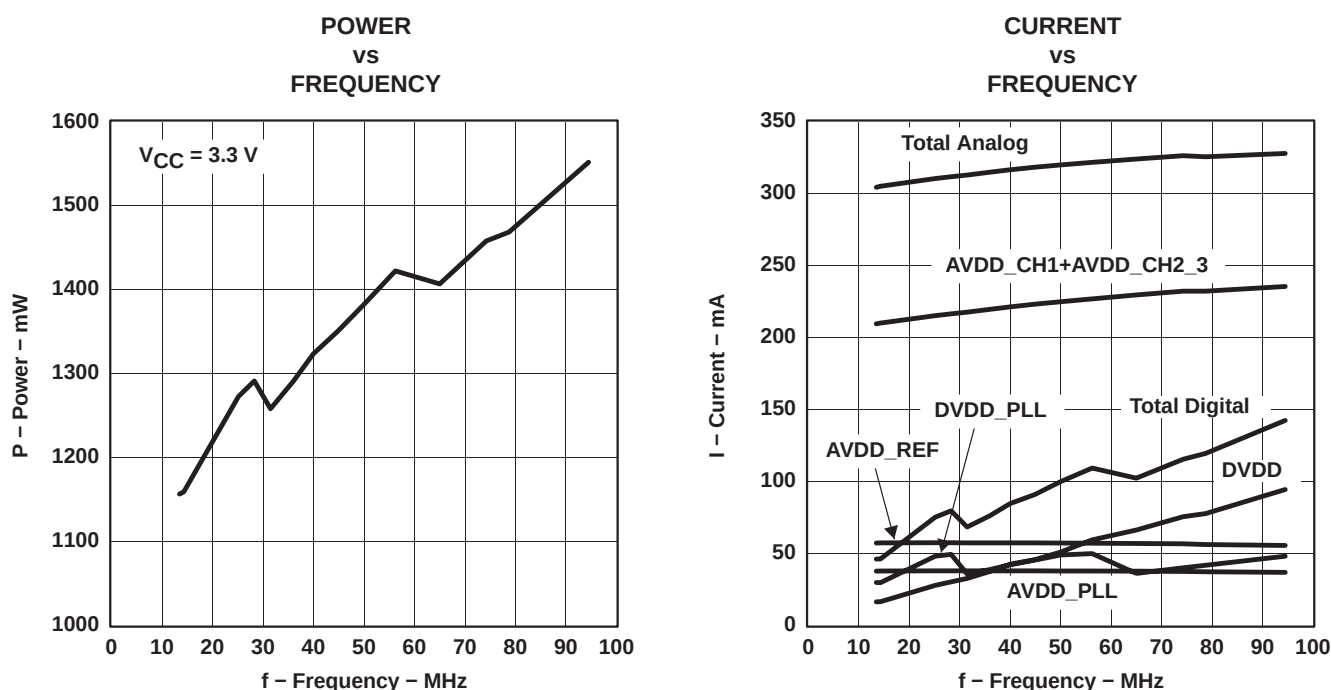


Figure 5-2. Power Consumption

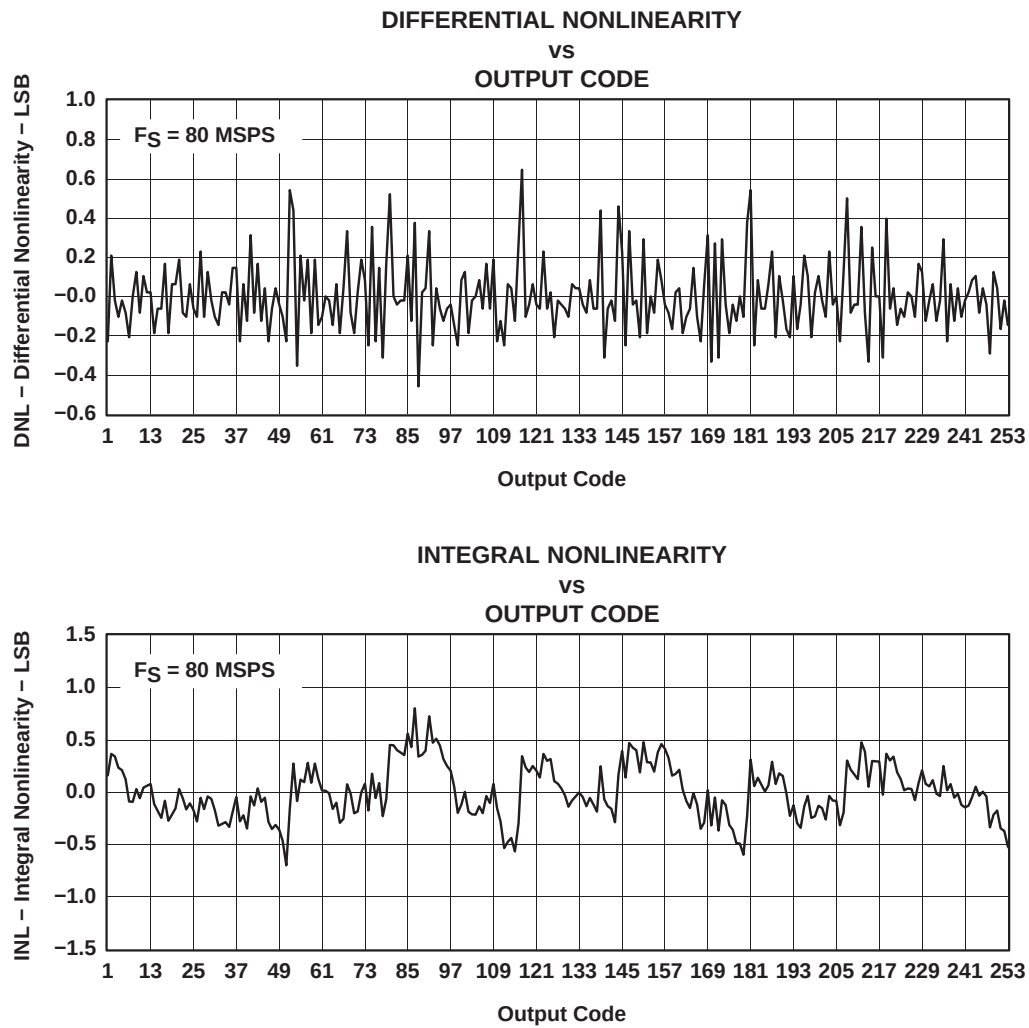


Figure 5–3. Linearity of AGY Channel at 80 MSPS (external clock)

## 6 Application Information

### 6.1 Designing With PowerPAD™

The THS8083A is housed in a high-performance, thermally enhanced, 100-pin PowerPAD package (TI package designator: 100PZP). Use of the PowerPAD package does not require any special considerations except to note that the PowerPAD, which is an exposed die pad on the bottom of the device, is a metallic thermal and electrical conductor. Therefore, if not implementing the PowerPAD PCB features, the use of solder masks (or other assembly techniques) may be required to prevent any inadvertent shorting by the exposed PowerPAD of connection etches or vias under the package. The recommended option, however, is not to run any etches or signal vias under the device, but to have only a grounded thermal land as explained below. Although the actual size of the exposed die pad may vary, the minimum size required for the keepout area of the 100-pin PZP PowerPAD package is 5 mm × 5 mm.

It is recommended that there be a thermal land, which is an area of solder-tinned-copper, underneath the PowerPAD package. The thermal land varies in size, depending on the PowerPAD package being used, the PCB construction, and the amount of heat that needs to be removed. In addition, the thermal land may or may not contain numerous thermal vias, depending on PCB construction.

More information on this package and other requirements for using thermal lands and thermal vias are detailed in the TI application note *PowerPAD Thermally Enhanced Package Application Report*, TI literature number SLMA002, available via the TI Web pages beginning at URL: <http://www.ti.com>

For the THS8083A, this thermal land should be grounded to the low impedance ground plane of the device. This improves thermal performance and the electrical grounding of the device. It is also recommended that the device ground terminal landing pads be connected directly to the grounded thermal land. The land size should be as large as possible without shorting device signal terminals. The thermal land may be soldered to the exposed PowerPAD using standard reflow soldering techniques.

While the thermal land may be electrically floated and configured to remove heat to an external heat sink, it is recommended that the thermal land be connected to the low impedance ground plane of the device.

Table 6-1 lists a comparison between the thermal resistances of the PowerPAD package (100PZP) used for this device and a regular 100-pin TQFP package.

**Table 6–1. Junction-Ambient and Junction-Case Thermal Resistances**

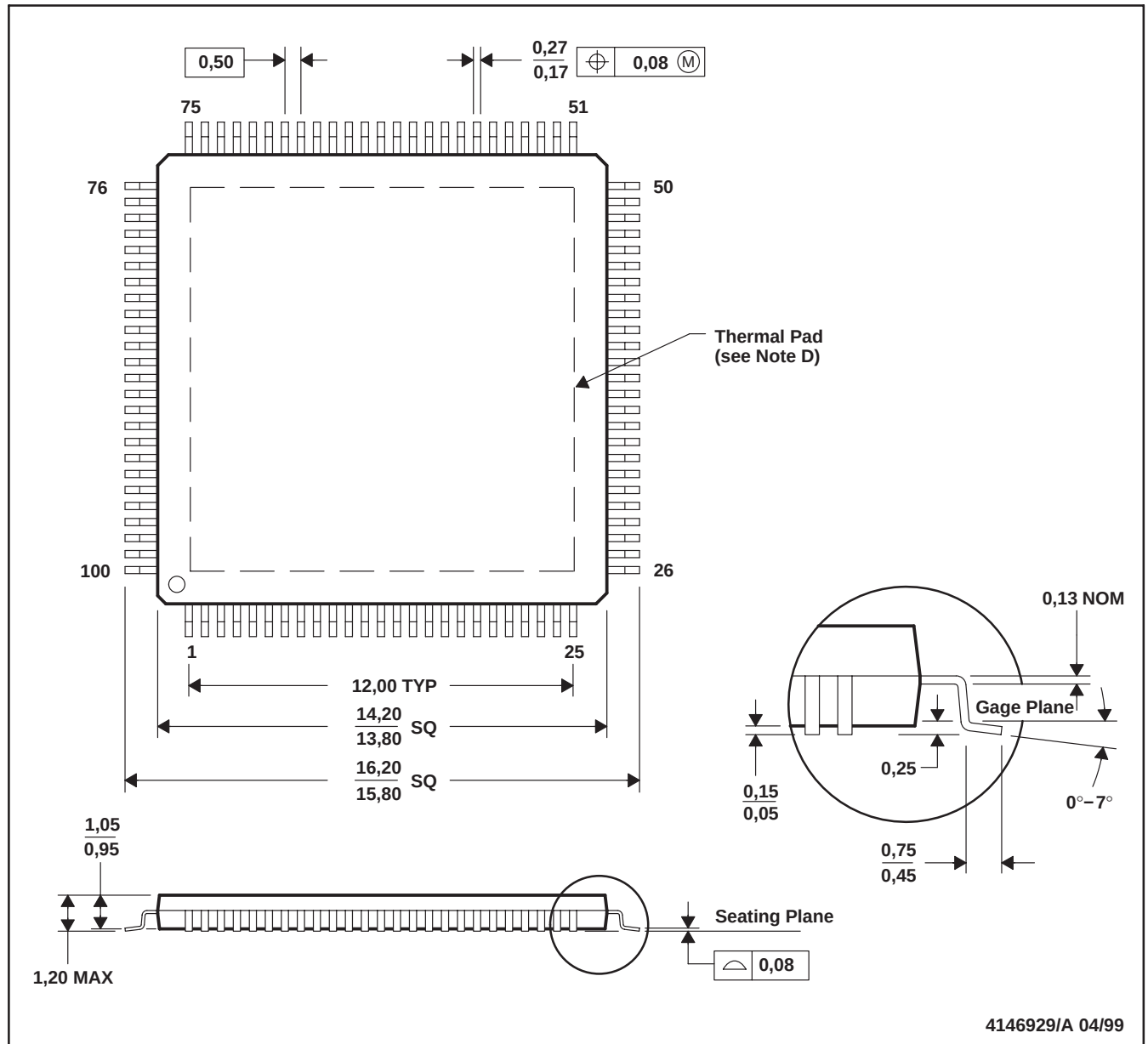
| 100 PZP PowerPAD™ vs<br>100 PIN REGULAR TQFP | AIRFLOW IN lfm |      |      |     |
|----------------------------------------------|----------------|------|------|-----|
|                                              | 0              | 150  | 250  | 500 |
| $\theta_{JA}$ (°C/W) 100 PZP                 | 17.3           | 11.8 | 10.4 | 9.0 |
| $\theta_{JC}$ (°C/W) 100 PZP                 | 0.12           |      |      |     |
| $\theta_{JA}$ (°C/W) 100 pin regular         | 49             |      |      |     |
| $\theta_{JC}$ (°C/W) 100 pin regular         | 3              |      |      |     |



## 7 Mechanical Data

PZP (S-PQFP-G100)

PowerPAD™ PLASTIC QUAD FLATPACK



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion.
  - The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.
  - Falls within JEDEC MS-026

PowerPAD is a trademark of Texas Instruments.



## Appendix A

### PLL Formulas and Register Settings

**If:**

F(XTL) = frequency of external crystal or master clock connected to XTL1 input of THS8083A

F(VCO) = frequency of THS8083A-internal VCO

F(DTO) = frequency of THS8083A-internal DTO

F(DTOCLK) = frequency of externally available DTO clock output

F(HS) = frequency of HS input

CLKDIV = clock output divider setting

VCODIV = feedback divider in THS8083A-internal analog PLL loop

TERMCNT = feedback divider in THS8083A-internal digital PLL loop

DTO\_INC = DTO increment (when NOM\_INC is programmed, DTO\_INC is initialized to NOM\_INC)

**Then:**

$F(VCO) = F(XTL) \times VCODIV$

$F(DTO) = 32 \times F(VCO) / DTO\_INC$

$F(DTOCLK) = F(DTO) / CLKDIV$

And, if PLL is locked:

$F(DTOCLK) = TERMCNT \times F(HS)$

**Summarizing:**

$DTO\_INC = [32 \times F(XTL) \times VCODIV] / [F(DTOCLK) \times CLKDIV]$

**The formats of DTO\_INC and NOM\_INC:**

Both are 33-bit values consisting of a 6-bit integer and a 27-bit fractional part. So, in hexadecimal notation, the value is between 00.000000hex and 3F.7FFFFFFFhex. The decimal value of the increment is: <integer part>.<fractional part interpreted as integer value> $\times 2^{(-27)}$ . This means, to arrive at the decimal value of the increment:

1. Interpret the 6 MSBs as an integer value
2. Interpret the 27 LSBs expressed as a decimal integer value and multiply this by  $2^{(-27)}$  to arrive at a fractional value
3. Add 1 and 2.

**Additional restrictions:**

- NOM\_INC must be within the range [16,32]. During an unlocked condition of the PLL (e.g., during video format changes), the user needs to take care that the instantaneous DTO increment does not go outside this valid range. This can be achieved by monitoring the SYNC\_DETECT register bit (for no video input) and the LOCK pin (for unlock) and disabling the PFD (DISABLE\_PFD register bit) when no video input or unlock is detected. This will keep the DTO operating at the nominal frequency. This update must be done within a few PFD updates (i.e., within a few video line periods) to avoid the DTO from drifting outside its valid range. When drifting outside this range, the DTO output might become unstable or absent. Since the I<sup>2</sup>C interface requires a valid DTO clock, I<sup>2</sup>C communication errors will occur (no I<sup>2</sup>C ACK) when a stable DTO clock is lost. When this happens, a hardware reset (/RESET pin) will be needed to recover.
- CLKDIV must be chosen for different output clock frequency ranges as shown in register map description for SEL\_CLK.

### Examples:

1. For generating the XGA@75Hz pixel clock of 78.75 MHz, with  $F(XTL) = 14.381818$  MHz and  $VCO_{DIV}=8$ :

$$NOM\_INC = [32 \times 14.381818 \times 8] / [78.75 \times 2] = 23.272724...$$

Since  $23d = 17h$  and  $INT(0.272724... \times 2^{27}) = 36604438d = 22E8A16$  hex, this can be written as  $0x17.22E8A16$  or as a contiguous 33 bit number:  $010111010001011101000101000010110 = 0BA2E8A16$  hex, i.e., the default setting for  $NOM\_INC$  (see register map).

To achieve lock with an incoming HS,  $TERMCNT$  is programmed with 1312 (i.e., the total number of pixels per line in this mode).

Below are the settings for popular video and graphics modes.

### VESA MODES

#### Mode #1: 640x350 at 85 Hz → fpix = 31.5 MHz, N = 832

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 832         | 340         | 40                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 29.090905   | 1d.0ba2c9c  | 9c                   |
| NOM_INC_1     |             |             | 2c                   |
| NOM_INC_2     |             |             | ba                   |
| NOM_INC_3     |             |             | e8                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 3                    |
| SEL_CLK       | 4           | 4           | 2                    |

#### Mode #2: 640x400 at 85 Hz → fpix = 31.5 MHz, N = 832 (same settings as 640x350 at 85 Hz)

#### Mode #3: 720x400 at 85 Hz → fpix = 35.5 MHz, N = 936

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 936         | 3a8         | a8                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 25.813057   | 19.68123fa  | fa                   |
| NOM_INC_1     |             |             | 23                   |
| NOM_INC_2     |             |             | 81                   |
| NOM_INC_3     |             |             | ce                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #4: 640x480 at 59.94 Hz → fpix = 25.175 MHz, N = 800**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 800         | 320         | 20                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 18.1998713  | 12.1995620  | 20                   |
| NOM_INC_1     |             |             | 56                   |
| NOM_INC_2     |             |             | 99                   |
| NOM_INC_3     |             |             | 91                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 8           | 8           | 03                   |

**Mode #5: 640x480 at 72 Hz → fpix = 31.5 MHz, N = 832 (same settings as 640x350 @ 85 Hz)**

**Mode #6: 640x480 at 75 Hz → fpix = 31.5 MHz, N = 840**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 840         | 348         | 48                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 29.090905   | 1d.0ba2c9c  | 9c                   |
| NOM_INC_1     |             |             | 2c                   |
| NOM_INC_2     |             |             | ba                   |
| NOM_INC_3     |             |             | e8                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #7: 640x480 at 85 Hz → fpix = 36.0 MHz, N = 832**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 832         | 340         | 40                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 25.454542   | 19.3a2e708  | 08                   |
| NOM_INC_1     |             |             | e7                   |
| NOM_INC_2     |             |             | a2                   |
| NOM_INC_3     |             |             | cb                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #8: 800x600 at 56.25 Hz → fpix = 36.0 MHz, N = 1024**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1024        | 400         | 00                   |
| TERM_CNT_1    |             |             | 04                   |
| NOM_INC_0     | 25.454542   | 19.3a2e708  | 08                   |
| NOM_INC_1     |             |             | e7                   |
| NOM_INC_2     |             |             | a2                   |
| NOM_INC_3     |             |             | cb                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #9: 800x600 at 60 Hz → fpix = 40.0 MHz, N = 1056**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1056        | 420         | 20                   |
| TERM_CNT_1    |             |             | 04                   |
| NOM_INC_0     | 22.909088   | 16.745cfee  | ee                   |
| NOM_INC_1     |             |             | cf                   |
| NOM_INC_2     |             |             | 45                   |
| NOM_INC_3     |             |             | b7                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #10: 800x600 at 72 Hz → fpix = 50.0 MHz, N = 1040**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HE10X) |
|---------------|-------------|-------------|------------------------|
| TERM_CNT_0    | 1040        | 410         | 10                     |
| TERM_CNT_1    |             |             | 04                     |
| NOM_INC_0     | 18.327270   | 12.29e3ff2  | f2                     |
| NOM_INC_1     |             |             | 3f                     |
| NOM_INC_2     |             |             | 9e                     |
| NOM_INC_3     |             |             | 92                     |
| NOM_INC_4     |             |             | 0                      |
| VCO_DIV       | 8           | 8           | 03                     |
| SEL_CLK       | 4           | 4           | 02                     |

**Mode #11: 800x600 at 75 Hz → fpix = 49.5 MHz, N = 1056**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1056        | 420         | 20                   |
| TERM_CNT_1    |             |             | 04                   |
| NOM_INC_0     | 18.512394   | 12.4196235  | 35                   |
| NOM_INC_1     |             |             | 62                   |
| NOM_INC_2     |             |             | 19                   |
| NOM_INC_3     |             |             | 94                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #12: 800x600 at 85 Hz → fpix = 56.25 MHz, N=1048**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1048        | 418         | 18                   |
| TERM_CNT_1    |             |             | 04                   |
| NOM_INC_0     | 16.290907   | 10.253c710  | 10                   |
| NOM_INC_1     |             |             | c7                   |
| NOM_INC_2     |             |             | 53                   |
| NOM_INC_3     |             |             | 82                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #13: 1024x768 at 43.4 Hz → fpix = 44.9 MHz, N = 1264**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1264        | 4f0         | f0                   |
| TERM_CNT_1    |             |             | 04                   |
| NOM_INC_0     | 20.408987   | 14.3459b05  | 05                   |
| NOM_INC_1     |             |             | 9b                   |
| NOM_INC_2     |             |             | 45                   |
| NOM_INC_3     |             |             | a3                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 4           | 4           | 02                   |

**Mode #14: 1024x768 at 60 Hz → fpix = 65.0 MHz, N = 1344**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1344        | 540         | 40                   |
| TERM_CNT_1    |             |             | 05                   |
| NOM_INC_0     | 28.195801   | 1c.190ffea  | ea                   |
| NOM_INC_1     |             |             | ff                   |
| NOM_INC_2     |             |             | 90                   |
| NOM_INC_3     |             |             | e1                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 2           | 2           | 01                   |

**Mode #15: 1024x768 at 70 Hz → fpix = 75.0 MHz, N = 1328**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1328        | 530         | 30                   |
| TERM_CNT_1    |             |             | 05                   |
| NOM_INC_0     | 24.436361   | 18.37daa97  | 97                   |
| NOM_INC_1     |             |             | aa                   |
| NOM_INC_2     |             |             | 7d                   |
| NOM_INC_3     |             |             | c3                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 2           | 2           | 01                   |

**Mode #16: 1024x768 at 75 Hz → fpix = 78.75 MHz, N = 1312**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1312        | 520         | 20                   |
| TERM_CNT_1    |             |             | 05                   |
| NOM_INC_0     | 23.272724   | 17.22e8a16  | 16                   |
| NOM_INC_1     |             |             | 8a                   |
| NOM_INC_2     |             |             | 2e                   |
| NOM_INC_3     |             |             | ba                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 2           | 2           | 01                   |

**Mode #17: 1024x768 at 85 Hz → fpix = 94.5 MHz, N = 1376**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1376        | 560         | 60                   |
| TERM_CNT_1    |             |             | 05                   |
| NOM_INC_0     | 19.393937   | 13.326c868  | 68                   |
| NOM_INC_1     |             |             | c8                   |
| NOM_INC_2     |             |             | 26                   |
| NOM_INC_3     |             |             | 9b                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 2           | 2           | 01                   |

**DTV MODES**

**1080I → fpix = 74.25 MHz, N = 2200**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 2200        | 898         | 98                   |
| TERM_CNT_1    |             |             | 08                   |
| NOM_INC_0     | 24.683192   | 18.5772d9b  | 9b                   |
| NOM_INC_1     |             |             | 2d                   |
| NOM_INC_2     |             |             | 77                   |
| NOM_INC_3     |             |             | c5                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 2           | 2           | 01                   |

**720P → fpix = 74.25 MHz, N = 1650**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 1650        | 672         | 72                   |
| TERM_CNT_1    |             |             | 06                   |
| NOM_INC_0     | 24.683192   | 18.5772d9b  | 9b                   |
| NOM_INC_1     |             |             | 2d                   |
| NOM_INC_2     |             |             | 77                   |
| NOM_INC_3     |             |             | c5                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 8           | 8           | 03                   |
| SEL_CLK       | 2           | 2           | 01                   |

**13.5 MHz, 864**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 864         | 360         | 60                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 29.696966   | 1d.59362df  | df                   |
| NOM_INC_1     |             |             | 62                   |
| NOM_INC_2     |             |             | 93                   |
| NOM_INC_3     |             |             | ed                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 7           | 7           | 02                   |
| SEL_CLK       | 8           | 8           | 03                   |

**13.5 MHz, N = 858**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 858         | 35a         | 5a                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 29.696966   | 1d.59362df  | df                   |
| NOM_INC_1     |             |             | 62                   |
| NOM_INC_2     |             |             | 93                   |
| NOM_INC_3     |             |             | ed                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 7           | 7           | 02                   |
| SEL_CLK       | 8           | 8           | 03                   |

**14.31818 MHz, N = 858**

| REGISTER NAME | VALUE (DEC) | VALUE (HEX) | REGISTER VALUE (HEX) |
|---------------|-------------|-------------|----------------------|
| TERM_CNT_0    | 858         | 35a         | 5a                   |
| TERM_CNT_1    |             |             | 03                   |
| NOM_INC_0     | 28.000000   | 1c.0000000  | 00                   |
| NOM_INC_1     |             |             | 00                   |
| NOM_INC_2     |             |             | 00                   |
| NOM_INC_3     |             |             | E0                   |
| NOM_INC_4     |             |             | 0                    |
| VCO_DIV       | 7           | 7           | 02                   |
| SEL_CLK       | 8           | 8           | 03                   |

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